

KIT – Kalaignarkarunanidhi Institute of Technology

(An Autonomous Institution)

Approved by AICTE, New Delhi & Affiliated to Anna University, Chennai Accredited by NAAC with 'A' GRADE & NBA (CSE, ECE, EEE, MECH) An ISO 9001 : 2015 Certified Institution Coimbatore – 641 402.

REGULATIONS, CURRICULUM & SYLLABUS – 2019

(Applicable for students admitted from the Academic Year 2019-20 onwards)

DEGREE OF MASTER OF ENGINEERING IN APPLIED ELECTRONICS



DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

R - 2019 -

Vision and Mission of the Department

Vision

To impart standard education, training and research in the field of Electronics and Communication
 Engineering and to produce globally proficient engineers.

Mission			
	Provide quality and contemporary education in the domain of ECE to produce globally competitive engineers.		
٥	Facilitates industry institution interaction in teaching & learning, consultancy and research activities to accomplish the technological needs of the society.		
0	Develop entrepreneurship qualities and good management practices by adhering to the professional ethical code.		

Program Educational Objectives (PEO's)		
PEO 1	Graduates will be working in multidisciplinary teams to develop feasible and sustainable solutions in the area of Signal Processing, Embedded Systems, and VLSI.	
PEO 2	Graduates will develop lifelong learning through research in academic, industry and research organizations.	

Programme	Outcomes	(PO's)
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After the successful completion of the P.G. programme in Applied Electronics, Graduates will be able to :

PO1 Engineering knowledge : Apply the knowledge of mathematics, science, engineering fundamentals, and an engineering specialization to the solution of complex engineering problems.

Problem analysis : Identify, formulate, review research literature, and analyze complex
 engineering problems reaching substantiated conclusions using first principles of mathematics, natural sciences, and engineering sciences.

PO 3 Design / development of solutions : Design solutions for complex engineering problems and design system components or processes that meet the specified needs with appropriate consideration for the public health and safety, and the cultural, societal, and environmental considerations.

PO 4	Conduct investigations of complex problems : Use research-based knowledge and research methods including design of experiments, analysis and interpretation of data, and	
	synthesis of the information to provide valid conclusions.	
PO 5	Modern tool usage : Create, select, and apply appropriate techniques, resources, and modern engineering and IT tools including prediction and modeling to complex engineering activities with an understanding of the limitations.	
PO 6	The Engineer and society : Apply reasoning informed by the contextual knowledge to assess societal, health, safety, legal and cultural issues and the consequent responsibilities relevant to the professional engineering practice.	
PO 7	Environment and sustainability : Understand the impact of the professional engineering solutions in societal and environmental contexts, and demonstrate the knowledge of, and need for sustainable development.	
PO 8	Ethics : Apply ethical principles and commit to professional ethics and responsibilities and norms of the engineering practice.	
PO 9	Individual and team work : Function effectively as an individual, and as a member or leader in diverse teams, and in multidisciplinary settings.	
PO 10	Communication : Communicate effectively on complex engineering activities with the engineering community and with society at large, such as, being able to comprehend and write effective reports and design documentation, make effective presentations, and give and receive clear instructions.	
PO 11	Project management and finance : Demonstrate knowledge and understanding of the engineering and management principles and apply these to one's own work, as a member and leader in a team, to manage projects and in multidisciplinary environments.	
PO 12	Life-long learning : Recognize the need for, and have the preparation and ability to engage in independent and life-long learning in the broadest context of technological change.	
Program Specific Outcome (PSO's)		
After the successful completion of the P.G. programme in Applied Electronics, Graduates will be able to :		

PSO 1	Examine various techniques for the design of innovative electronic applications.
PSO 2	Test the performance of various applications through domain specific tools.

R. Jane) **BoS Chairman**

PG Regulations

R - 2019 -

1. SHORT TITLE AND COMMENCEMENT

- These Regulations shall be called the "KIT-Kalaignarkaraunanidhi Institute of Technology, Coimbatore, Regulations for the Award of M.E. / M.B.A / M.C.A., Degree".
- They have been evolved, drafted and implemented after deliberations in and approvals from UGC, Anna University and Academic Council of the Institute, and are subject to change / modifications from time to time; (major modifications at a frequency of FOUR years in synchronization with the curriculum structure revision and minor changes as and when applicable).
- The latest/first version shall be applicable for the students enrolling for M.E. / M.B.A / M.C.A., degree programs at this Institute from Academic year 2019-2020 onwards.

2. PREAMBLE

The regulations prescribed herein have been made by KIT, an autonomous institution, approved by AICTE,New Delhi and affiliated to the Anna University, Chennai, to facilitate the smooth and orderly conduct of its academic programmes and activities at the M.E. / M.B.A / M.C.A. level. It is expected that the regulations will enable the students to take advantage of the various academic opportunities at the Institute and prepare themselves to face the challenges in their professional careers ahead. It may be noted that :

- a. The provision made herein shall be applicable to all the M.E./M.B.A/M.C.A.,. programmes offered at the institute, at present;
- b. They shall also be applicable to all the new M.E./M.B.A/M.C.A., programmes which may be started at the Institute in the future; COIMBATORE
- c. Academic and non-academic requirements prescribed by the Academic Council have to be fulfilled by a student for eligibility towards award of M.E. / M.B.A / M.C.A., Degree.

3. PRELIMINARY DEFINITIONS AND NOMENCLATURE

In these Regulations, unless the context otherwise requires :

SI. No.	Name	Definition
1.	Programme	Refers to Degree Programme that is B.E./B.Tech. Degree Programme.
2.	Discipline	Refers to branch or specialization of B.E./B.Tech. Degree Programme, like Computer Science and Engineering, Mechanical Engineering etc.,
3.	Course	Refers to a theory or practical subject that is normally studied in a semester, like Mathematics, Physics, etc.,
4.	Head of the Institution	Refers to the Principal of the College.

5.	Controller of Examinations (CoE)	Refers to the authority of the college who is responsible for all activities of the Examinations.	
6.	Head of the Department (HoD)	Refers to the Head of the Department concerned.	
7.	University	Refers to Anna University, Chennai.	
8.	College (KIT)	Refers to KIT-Kalaignarkarunanidhi Institute of Technology, Coimbatore.	
9.	Curriculum	Refers to the various components/courses studied in each programme that provide appropriate outcomes (knowledge, skill and behavior/attitude) in the chosen branch of study.	
10.	T-P-TU-C	Refers to Theory, Practical, Tutorial and Credits respectively.	
11.	Foundation Courses (FC)	May include Mathematics or other basic courses	
12.	Professional Core (PC)	Courses include the core courses relevant to the chosen specialization/branch.	
13.	Professional Elective (PE)	Courses include the elective courses relevant to the chosen specialization/ branch.	
14.	Project Work (PW)	Refers to the project done by a student or a group of students during final year.	
15.	Career Enhancement Courses (CEC)	Includes Mini Project Work and / or Internship, Seminar, Professional Practices, Case Study, soft skills and Industrial / Practical Trainings etc.,	
16.	Academic Evaluation Committee (AEC)	The committee includes Principal, CoE, HoD concerned (For details refer Appendix V)	
17.	Department Evaluation Committee (DEC)	The committee included HoD (need basis), senior faculty member(s) of department from various levels, class advisor, Mentor of the students. (For details refer Appendix V)	

4. ADMISSION

4.1 Candidates seeking admission to M.E. / M.B.A / M.C.A., Degree Programme :

Candidates for admission to the first semester of the Post-Graduate Degree Programme shall be required to have passed an appropriate Under-Graduate Degree Examination of Anna University or equivalent as specified under qualification for admission as per the Tamil Nadu Common Admission (TANCA) criteria.

Candidates for admission to the III semester of the M.C.A Degree Programme shall be required to have passed an appropriate Under-Graduate Degree Examination of Anna University or equivalent as specified under qualification for admission as per the Government of Tamil Nadu.

Note : TANCA releases the updated criteria during the admissions every academic year.

Admission shall be offered only to the candidates who possess the qualification prescribed against each programme.

Any other relevant qualification which is not prescribed against each programme shall be considered for equivalence by the committee constituted for the purpose. Admission to such degrees shall be offered only after obtaining equivalence to such degrees.

4.2 Re - admission

Students, who have discontinued for reasons other than disciplinary action, may be readmitted as per guidelines given by DoTE, Government of Tamilnadu and Anna University. Department Evaluation Committee (DEC) shall study and recommend on the exception and addition of courses to be registered for, by the student concerned during re-admission. The details shall be forward to Academic Evaluation Committee (AEC) for approval and the committee's decision shall be final.

5. PROGRAMMES OFFERED

KIT offers 2 year (4 Semesters) M.E.. / M.B.A., and 3 year (6 Semesters) M.C.A., Degree programme affiliated to Anna University, under Choice Based Credit System (CBCS) for students admitted from 2019 onwards in the following branches of Engineering and Technology as in Table 1.

M.E., Applied Electronics
M.E., VLSI Design
M.E., Engineering Design
M.E., Computer Science and Engineering
M.E., Power Systems and Engineering
M.B.A., Master of Business Administration
M.C.A., Master of Computer Application

Table 1. List of M.E. / M.B.A / M.C.A., programmes offered

6. ACADEMIC STRUCTURE OF PROGRAMMES

6.1 Medium of Instruction

The medium of instruction is English for all courses, examinations, seminar presentations and project / thesis / dissertation.

6.2 Categorization of Courses

Every Post Graduate Degree Programme will have a curriculum with syllabi consisting of theory and practical courses that shall be categorized as follows :

- i. Foundation Courses (FC) may include Mathematics or other basic courses
- ii. **Professional Core (PC)** courses include the core courses relevant to the chosen specialization/branch.
- iii. **Professional Elective (PE)** courses include the elective courses relevant to the chosen specialization/ branch.
- iv. Project Work (PW) includes Project Work to be done in final semester
- Carrear Enhancement Courses (CEC) includes Mini Project Work and/or Internship, Seminar, Professional Practices, Summer Project, Case Study and Industrial / Practical Training.

Instead of two electives in the curriculum, the student may be permitted to choose a maximum of 2 courses from other PG programmes with the approval of the Head of the Department offering such courses.

6.3 Number of courses per semester

Curriculum of a semester shall normally have a blend of lecture courses and practical courses including Career Enhancement Courses. Each course may have credits assigned as per clause 6.4.

6.4 Credit Assignment

Each course offered is given a T-P-TU-C structure, depending on the number of lecture periods (T), number of periods for practical (P) and number of tutorial periods (T) required per week for an efficient teaching – learning process. A student is expected to put-in his/her own efforts in proportion with periods spent in classroom, as defined in T-P-TU-C structure. On successful completion of the course a student is said to have earned a specified number of credits defined for each course. Each course is assigned certain number of credits based on the following table :

Contact period per week	Credits
1 Lecture Period (T = Lectures given during class by the faculty)	1
1 Tutorial Periods (TU = Tutorial, also class based with more emphasis on problem solving)	1
2 Practical Period (P) (Laboratory Periods / CEC / Projects)	1

Table 4 : Credit Assigned

6.5 Career Enhancement Courses

6.5.1 Industrial Training / Internship

Students shall undergo industrial training/Internship if mandated in the curriculum for periods as specified in the curriculum during the summer/winter vacation, the training being taken on a continuous basis for the periods mentioned. The industry/organization is to be selected with the approval of the Department Evaluation Committee (DEC). Industrial training may also be referred to as "In-plant training".

The Industrial Training / Internship shall carry 100 marks and shall be evaluated through CIA only. The credit will be awarded to the student after the submission of Internship/Training report to the HoD. The report will be evaluated by a team of (DEC) faculty members nominated by the HoD for awarding the Credit. Based on the recommendation by the team, the student will be awarded credits and the results will be sent to the Controller of Examinations. The awarded credit will taken for CGPA calculation. The final year project period at industry/research organization will not be considered as industrial Training/internship.

6.5.2 Industrial Visit

Every student is required to go for at least one Industrial Visit every year starting from the second year of the Programme subject to the approval of the Head of the Department and Principal. The Heads of Departments shall ensure that necessary arrangements are made in this regard.

6.5.3 Professional Certificate Courses

Students have to undergo one credit courses offered by experts from industry / research organizations and approved by academic council. Students can register such courses from his/her second year of study as and when these courses are conducted by the departments. A student is also permitted to register for these courses of other departments.

If a student does not successfully complete the registered industry supported one credit courses in a semester, the registration of that course will be considered as cancelled. Further, it will not be treated as arrear and if he/she wishes, he/she can reregister for the same course in the ensuing semesters and successfully complete it as and when it is offered subsequently.

6.5.4 Online Courses

Students may be permitted to register for online courses (which are provided with certificate after evaluation of the performance, SWAYAM/NPTEL), during third to sixth semester of his/her study. On successful completion of the course, he/she has to submit the copy of the certificates to the Head of the Department. The assemment will not be calculated for CGPA.

6.5.5 Soft Skills

Every Student is required to go for two soft skill courses during first year of study. The soft skill course includes the communication skill, interpersonal skill and career

development courses. One credit will be awarded for each soft skills courses and it will be included for SGPA/CGPA calculations.

6.5.6 Career Ability Course

The career Ability courses will be designed by the respective department with approval from DEC/AEC based on the industry requirements. One credit will be awarded for each soft skills courses and it will be included for SGPA/CGPA calculations.

6.5.7 Evaluation of One Credit Courses

Students can register for one credit courses in any semester when it is offered. Experts from the industry/Institution (KIT) may design such specialized one-credit courses based on the current technical skill requirements. The Department Evaluation Committee (DEC) shall review and approve the syllabus, course plan, and pedagogy and assessment pattern for the course. One credit courses can also be offered by internal experts i.e faculty members from other departments (not belonging to the specific discipline of the programme) also can offer such courses to the students with the approval of DEC.

A one - credit course shall carry 100 marks and shall be evaluated through Continuous Internal Assessment (CIA) only. The QP pattern and scheme will be decided by the course faculty and will be approved by the DEC/AEC.

The Head of the Department may identify a faculty member as the coordinator for the course. A committee consisting of the Head of the Department, faculty handling the course (if available), coordinator and a senior Faculty member nominated by the Head of the Department shall monitor the evaluation process.

The grades shall be assigned to the students by the above committee based on their performance and included in the calculation of CGPA.

6.5.8 Industry Supported Project Work

The students satisfying the following conditions shall be permitted to carry out their final semester Project work for six months in industry/research organization.

The student should not have current arrears and shall have CGPA of 8.0 and above until 2nd semester (for MBA / ME Students), 4th semester (for MCA students) The student shall undergo the final semester courses in the Pre semester. The Head of Department, in consultation with the faculty handling the said courses shall forward the proposal recommended by the Principal to CoE after approval from AEC at least four weeks before the commencement of the pre - semester of the programme.

6.6 Course Numbering Scheme

Each course is denoted by a unique code consisting of 9 alphanumeric characters. The details of the numbering scheme are in **ANNEXURE - I**.

6.7 Credit Requirement for Programmes

The total number of credits that a student earns during the period of study is called the Total credits. The minimum prescribed credits required for the award of the degree shall be within the limits specified below :

Programme	KIT Credit Range	
M.E. / M.Tech.	66-72	
Programme	KIT Credit Range	
M.B.A.	102	
M.C.A. (Regular)	120	
M.C.A. (Lateral)	77	

7. DURATION OF THE PROGRAMMES

7.1 The minimum and maximum period for completion of the P.G. Programmes are given below :

Programme	Min. No. of Semesters	Max. No. of Semesters
M.E. / M.Tech. (Full-Time)	4	8
M.B.A. (Full Time)	4	8
M.C.A. (Full Time)	6	12
M.C.A.(Lateral)	4	8

- 7.2 The Curriculum and Syllabi of all the P.G. Programmes shall be approved by the Academic Council of KIT. The number of Credits to be earned for the successful completion of the programme shall be as specified in the Curriculum of the respective specialization of the P.G. Programme.
- 7.3 Each semester normally consists of 90 working days, including test and examination days. In any contingent situation, the number of working days per semester shall not be less than 65 days. The Principal is given the discretionary powers to decide the number of working days. In such contingencies, the Principal shall ensure that every faculty member teaches the full content of the specified syllabus for the course being taught.
 - 7.3.1 Due to Pandemic / Abnormal situations the Scheme of Examinations and Evaluation will be followed as per the guidelines issued by the Government of Tamil Nadu and Anna University, Chennai.
- **7.4** The total period for completion of the programme reckoned from the commencement of the first semester to which the candidate was admitted shall not exceed the maximum period specified in clause 7.1 irrespective of the period of break of study in order that he/she may be eligible for the award of the degree.
- **7.5** For the purpose of regulations, the academic year will be divided into two semesters, the odd semester normally spanning from June to November and the even semester from December to May.

8. COURSE REGISTRATION

Each student, on admission shall be assigned to a mentor who shall advice and counsel the student about the details of the academic programme and choice of courses, considering the student's academic background and career objectives. Some courses require students to register through a course registration process via online.

8.1. Course Registration

Each student on admission shall register for all the courses prescribed in the curriculum in the students first semester of the study.

The registration process for the courses offered in the online registration mode in the forthcoming semester, will commence preferably 10 working days prior to the last working day of the current semester.

A department shall offer a course only if a minimum number of students register for that course. This minimum number may vary from course to course and shall be specified by the department from time to time.

After registering for a course, a student shall attend the classes, satisfy the attendance requirements, earn Continous Assessment Marks and appear for the End Semester Examination (ESE).

8.2 Credits details for Course Registration

Each student has to register for all courses to be undergone in the curriculum of a particular semester (with the facility to drop courses to a maximum of 6 credits). The student can also register for courses for which the student has failed in the earlier semesters.

The registration details of the candidates may be approved by the Head of the Institution and forwarded to the Controller of Examinations. This registration is for undergoing the course as well as for writing the End Semester Examinations.

The courses that a student registers in a particular semester may include

- Occurses of the current semester.
- O The core (Theory / Lab / CEC) courses that the student has not cleared in the previous semesters.
- Elective courses which the student failed (either the same elective or a different elective instead)

8.3 Flexibility to Drop courses

A student has to earn the total number of credits specified in the curriculum of the respective programme of the study in order to be eligible to obtain the degree. From II semester to Final semesters, the student has the options for dropping an existing course. The total number of credits that a student can drop is limited to 6. Practical courses cannot be dropped.

8.4 Reappearance Registration

8.4.1 If a student fails in a theory or practical course, the student shall do reappearance registration for that course in the subsequent semester by retaining the Continuous Assessment Marks already earned.

- **8.4.2** If the theory course, in which the student has failed, is a Professional Elective or an Open Elective, the student may register for the same or any other Professional Elective or Open Elective course respectively in the subsequent semesters. Such changes can be done only with due approval by DEC.
- **8.4.3** The student who fails in Project work/ Seminar other than Practical courses shall register for the same in the subsequent semester and reappear for the End Semester Examination.
- **8.4.4** If a student is not eligible to appear for end semester examination of a course due to lack of attendance, the student has to register for that course again, when offered next, attend the classes and fulfill the attendance requirements. If the course, in which the student has lack of attendance, is an elective, the student may register for the same or any other elective in the subsequent semesters.
- **8.4.5** If a student has completed the 8 semesters and has obtained RA grade in one or more courses, he can register and appear for arrear examination directly whenever conducted next.
- **8.4.6** A student who has already appeared for a course in a semester and passed the examination is not entitled to reappear the same course for improvement of Grade/ Marks.

9. REQUIREMENTS FOR APPEARING FOR CIA, ESE

9.1 A student who has fulfilled the following conditions shall be deemed to be eligible to appear for the CIA-I, CIA-II, CIA-III and ESE. Ideally, every student is expected to attend all the classes and earn 100% attendance. Students who have earned not less than 75% attendance course wise taking into account the number of periods required for that course as specified in the curriculum. Table 5 illustrates the mandatory attendance requirement for CIA-I, CIA-II, CIA-III and ESE.

Test / Examination Type	Period of Calculation	Minimum % of attendance required
Continuous Internal Assessment Test I (CIA - I)	First Semester From the date of joining of course to three working days before the start of CIA - I	60%
	Second to Eighth semester From the date of commencement of the class to one week before the start of CIA - I	75%

 Table 5 : Mandatory Attendance Requirement for CIA-I, CIA-II, CIA-III and ESE.

Continuous Internal Assessment Test - II (CIA - II)	From the date of joining (1stsemester) / date of commencement of class (2 nd to 8 th Semester) to one week before the start of CIA - II	75% (for students maintaining 80% or more attendance between CIA - I and CIA - II, but falls short of the 75% cumulative requirement, the requirement may be relaxed if recommended by the AEC)
Continuous Internal Assessment Test III (CIA-III)	From the date of joining (1 st semester) / date of commencement of class (2 nd to 8 th Semester) to one week before the start of CIA - III	75% (for students maintaining 80% or more attendance between CIA - II and CIA - III but falls short of the 75% cumulative requirement, the requirement may be relaxed if recommended by the AEC)
End Semester Examination (ESE)	From the date of joining (1 st semester) / date of commencement of class (2 nd to 8 th Semester) to the last day of instruction.	75%

- **9.1.1** Students having a CGPA of 8.50 and above and with no standing arrears will be exempted from the minimum attendance requirements (from 7th Sem. onwards).
- **9.1.2** A student shall normally be permitted to appear for End Semester Examination of the course if he / she has satisfied the attendance requirements (vide Clause -9.1). He /she is eligible to register for ESE in that semester by paying the prescribed fee.
- **9.1.3** A Candidate who has fulfilled the following conditions shall be deemed to have satisfied the requirements for completion of a semester. Ideally every student is expected to attend all classes of all the courses and secure 100% attendance. However, in order to give provision for certain unavoidable reasons such as Medical / participation in sports, the student is expected to attend atleast 75% of the classes. Therefore, he/she shall secure not less than 75%.
- **9.1.4** However, a candidate who secures overall attendance between 65% and 74% in the current semester due to medical reasons (prolonged hospitalization / accident / specific illness) / Participation in Sports events may be permitted to appear for the current semester examinations subject to the condition that the candidate shall submit the medical certificate / sports participation certificate attested by the Head of the Institution. The same shall be forwarded to the Controller of Examinations for record purposes.

- 9.1.5 Candidates who secure less than 65% overall attendance and candidates who do not satisfy the clause 9.1.3 and 9.1.4 shall not be permitted to write the semester examination at the end of the semester and not permitted to move to the next semester. They are required to repeat the incomplete semester in the next academic year, as per the norms prescribed.
- **9.1.6** The students who are consistently good in academics ONLY be considered for the grant of ODL under Co-curricular activities by the competent authorities. The following activities shall be considered for the sanction of ODL;
 - Sports and Games : TIES, Inter Collegiate, Inter Zonal, Inter University, State Level, National Level and Open Tournaments.
 - () NCC : Camps and expeditions, NSS camps
 - O Cultural Programme at State, National and International Level
 - Seminar / Symposia : Paper presentation/Quiz
 - Substitution Leadership courses organized by other organizations & Alumni Association activities, Association activities, Placement activities.

 - > Personal damage incurred during the extracurricular activities
 - The ODL requisition letter shall be forwarded to the Principal through the HoD of the student by the staff-in-charge of the respective activities before completion of every activity.
 - The ODL sanctioned letters shall be submitted to the Department Office. The faculty-in-charge of the department office will check the eligibility for the award of attendance at the end of semester and the same may be submitted to DEC for approval.
- **9.1.7** The student should register all the courses of current semester and all the arrear courses in the previous semesters. If any student fails to register and pay the examination fees within the due date, he / she shall not be permitted to attend the End Semester Examinations. However, he / she will be permitted to continue their studies in the next higher semester, provided that the student satisfies the requirements as stipulated in this clause of this regulation.
- **9.1.8** Those students who are not deemed to have completed the semester with references to the conditions specified above shall undergo the semester again in all the courses in the respective semester during next academic year. He/she shall seek re-admission as per the norms of the affiliating University / DOTE (Directorate of Technical Education).

The days of suspension for a student on disciplinary grounds will be considered as days of absence for calculating the percentage of attendance for each individual course.

10. PROVISION FOR WITHDRAWAL FROM EXAMINATION

A student may, for valid reasons (medically unfit / unexpected family situations/Sports person representing Tamilnadu / India with prior permission for participation from Principal / CoE / DEC), be granted permission to withdraw (after registering for the examinations) from appearing for any course or courses in the End Semester Examination of a particular semester. The student may withdraw by following the due process of the CoE's office before the commencement of examination. This facility can be availed only once during the entire duration of the degree programme.

Withdrawal from ESE will be valid only if the student is, otherwise, eligible to write the examination and the application for withdrawal is made to the CoE, prior to the examination in the course or courses concerned. The application for withdrawal should be recommended by the Head of the Department concerned and approved by the Head of the Institution.

11. TEMPORARY BREAK OF STUDY FROM A PROGRAMME

- 11.1 Break of study is normally not permitted. However, if a student intends to temporarily discontinue the programme in the middle of a semester / year for valid reasons (such as Internships, accident or hospitalization due to prolonged ill health) and wishes to re-join the programme in the next academic year, he / she shall apply in advance to the Principal through the Head of the Department, stating the reasons. The application shall be submitted not later than the last date for registering for the semester examinations. Break of study is permitted only once during the entire period of the degree programme.
- **11.2** The student permitted to re-join the programme after the break shall be governed by the rules and regulations in force, at the time of re-joining.
- 11.3 The duration specified for passing all the courses for the purpose of classification of degree(vide clause 19) shall be increased by the period of such break of study permitted(vide clause 11)
- **11.4** If a student is detained for want of requisite attendance, academic progress and good conduct, the period spent in that semester shall not be considered as permitted Break of Study and Clause 11.3 is not applicable for such cases.

12. ASSESSMENT PROCEDURES FOR AWARDING MARKS

The total marks for each course generally (Theory, Practical, Project Work) will be 100, comprising of two components namely Continuous Internal Assessment (CIA) and End Semester Examination (ESE). However, there could be some open elective courses, human excellence courses, one credit industry courses, add-on courses and Mandatory courses that have only continuous assessment for 100 marks without an End Semester Examination. The Department Consultative Committee (DCC) has to approve such courses every semester. The scheme of assessment may also be decided by the faculty handling the course concerned with the approval from DCC and shall be made available to the students during the online course registration. Each course shall be evaluated for a maximum of 100 marks as illustrated in Table 6.

S. No.	Category of course	Continuous Internal Assessment	Semester End Examinations
1.	Theory Courses		
2.	Laboratory Courses	40 Marks	60 Marks
3.	Project Work		
4.	Career Enhancement Course (CEC) and Mandatory Course (MC)	100 Marks	-

Table 6 : Course Evaluation

The End Semester Examination (theory and practical) of 3 hours duration shall ordinarily be conducted between October and December during the odd semesters and between April and June during the even semesters.

The End Semester Examination for project work shall consist of evaluation of the final report submitted by the student or students of the project group (of not exceeding 4 students) by an external examiner and an internal examiner, followed by a viva-voce examination conducted separately for each student by a committee consisting of the external examiner, the supervisor of the project group and an internal examiner.

For the End Semester Examination in both theory and practical courses including project work the internal and external examiners shall be appointed by the Controller of Examinations..

13. MARKS DISTRIBUTION

13.1 Attendance Mark

Marks are awarded for the attendance earned by the students for individual courses as per the following table.

Attendance Range in %	Marks to be earned by the students
96 - 100	5
91 - 95	4
86 - 90	3
81 - 85	2
75 - 80	1

13.2 Question paper pattern

a. Table 7.1 Continuous Internal Assessment

(CIA - I, CIA – II and CIA – III)

2 Marks	12 Marks	Total marks
7	3 (Either or Type)	50

2 Marks	13 Marks	15 marks	Total Marks		
10	5 1 (Either or Type) (Either or Type)		100		
For Mathematics paper only					
2 Marks	16 Marks Total Marks				
10	5 (Either	100			

b. Table 7.2 Midsem and Semester End Examinations

13.3 Theory Courses

Continuous Internal Assessment tests are conducted by the Office of the Controller of Examination. Continuous Internal Assessment comprises three Continuous assessment tests, Assignment / Class test / Presentation / Online Test / Mini projects / Tutorials and Attendance. By adopting this method, the students will go through a continuous and systematic study pattern. The Corresponding weightages are given below.

Table 8 : Continuous Internal Assessment Test for Theory Courses

Particulars	Syllabus	Duration	Exam Mark	Internal Mark
Continuous Internal Assessment - I	rnal 1.5 Units 1.5 hours 50 marks		10	
Continuous Internal Assessment - II	1.5 Units	1.5 hours	50 marks	10
Continuous Internal Assessment - III1.5 Units1.5 hours50 marks		50 marks	10	
Assignment / Cla Tutorial / Presentati	5			
	5			
	40			

13.4 Criteria for Assessment for Lab Courses

Every exercise / experiment in all practical courses shall be valuated on a continuous basis. The criteria for Continuous Assessment (for each cycle of exercise/experiment) are given in Table 9.

SI. No.		Description	Weightage
1.	Со	ntinuous Internal Assessment Marks (CIAM)	
	a.	Average of Experimental Report / Workbook	25
	b.	Model examination	10
	C.	Attendance	5
	Tot	al CIAM	40
2.	Se	mester End Exam Marks (SEEM)	
	a.	Lab Examination with Viva Voce	60
	Tot	al ESEM	60
		Total Marks	100

 Table 9 : Assessment for Lab Courses

13.5 PROJECT WORK

For Project Work (Phase I & II) out of 100 marks, the maximum marks for Continuous Assessment is 40 marks and that for the End Semester Examination (project report evaluation and viva-voce examination) is 60 marks. Project work may be assigned to a single student or to a group of students not exceeding 4 per group, under the supervision of faculty guide(s).

The Head of the Department shall constitute a review committee for each programme. There shall be a minimum of three faculty members in the review committee. There shall be three reviews (as per **Table 10**) in total, during the semester by a review committee. The student shall make presentation on the progress made before the committee.

Interim project report shall be submitted before the project reviews with the approval of the guide. The Project Report, prepared according to the approved guidelines and duly signed by the guide and the Head of the Department, shall be submitted to the department as per the timeline announced by the department. The End Semester Examination for project work shall consist of evaluation of the final project report by an external examiner, followed by a viva-voce examination conducted separately for each student, by a committee consisting of the external examiner, and an internal examiner. The Controller of Examinations (CoE) shall appoint Internal and External Examiners for the End Semester Examination of the Project Work.

A candidate may, however, in certain cases, be permitted to work on projects in an Industrial/Research Organization, on the recommendations of the Head of the Department Concerned. In such cases, the Project work shall be jointly supervised by a supervisor of the department and an expert, as a joint supervisor from the organization and the student shall be instructed to meet the supervisor periodically and to attend the review committee meetings for evaluating the progress.

The Project work (Phase II in the case of M.E/M.Tech.) shall be pursued for a minimum of 16 weeks during the final semester.

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The deadline for submission of final Project Report is 60 calendar days from the last working day of the semester in which project / thesis / dissertation is done. However, the Phase-I of the Project work in the case M.E. / M.Tech. Programmes shall be submitted within a maximum period of 30 calendar days from the last working day of the semester as per the academic calendar published by the University.

The Continuous Internal Marks (CIM) and Semester End marks (SEM) for Project Work and the Viva-Voce Examination will be distributed as indicated in Table 10.

SI.No.	Review No.		Description	Marks	Total Marks	
		Co	ontinuous Internal Assessr	ment Marks		
		Deview 1	Review Committee	5	10	
	a.		Guide	5	10	
1.	h	Review 2	Review Committee	7	15	
	D.	Review 2	Guide	8	15	
	C	a Daview 2	Review Committee	7	15	
	C. Review 3		Guide	8	10	
Total CAM					40	
		Щ	Semester End Examination	ns Marks		
		Evaluation of	Internal Examiner	10		
2.	a.	final report and viva-voce	External Examiner	40	50	
	b.	Outcome*	Publication of papers / prototype / patents etc.,	10	10	
	Total ESEM				60	
Total Marks				100		

Table 10 : CIM and SEM break-up for project work

Review committee consists of internal faculty members nominated by the Head of the Department. The guide of student being examined shall not be part of the committee.

* Outcome – in terms of paper publication, patents, product development and industry projects shall be awarded by both internal and external examiners, based on the document proofs submitted by the student concerned.

If a student fails to submit project report / does not appear for the ESE /fails in the End Semester Examination (ESE)/ fails in Continuous Internal assessment (CIA) he/she is deemed to have failed in the project work and shall have to re-register for the same when offered next.

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14. PASSING REQUIREMENTS

- **14.1** A student is declared to have successfully passed a theory based course if he / she has secured:
 - () A minimum of 50% marks in the End Semester Examinations.
 - A minimum of 50% marks on combining both Continuous Internal Assessment Marks (CIAM) and End Semester Examination Marks (ESEM).
- **14.2** A student is declared to have successfully passed a practical / project based course if he/she has secured:
 - () A minimum of 50% marks in the End Semester Examinations.
 - A minimum of 50% marks on combining both Continuous Internal Assessment Marks (CIAM) and End Semester Examination Marks (ESEM).
- **14.3** For a student who does not meet the minimum passing requirements, the term "RA" against the course will be indicated in his/her grade sheet. He/she shall reappear in the subsequent examinations for the course as arrear or re-register for the course when offered .
- 14.4 For a student who is absent for end-semester theory / practical / project viva-voce, the term "RA" will be indicated against the corresponding course. He/she shall reappear for the End Semester Examination of that course as arrear in the subsequent semester or when offered next.
- **14.5** The letter grade "W" will be indicated for the courses for which the student has been granted authorized withdrawal (refer Clause 10).
- **14.6** For mandatory courses (non-credit), the student must satisfy the minimum attendance requirement & passing criteria as specified for the course as detailed in Section 16.2

15. METHODS FOR REDRESSAL OF GRIEVANCES IN EVALUATION

Students who are not satisfied with the grades awarded in the End Semester Examination of Theory for regular and arrear exams can seek redressal as illustrated in Table 11.

SI No	Podrossal Sought	Methodology				
51. NO.	Redressal Sought	Regular Exam Arrear Exam				
1.	Revaluation	 Apply for photo copy of answer book Then apply for revaluation after course expert recommendation 				
2.	Challenge of Evaluation	 Apply for photo copy of answer book Then apply for revaluation after course expert recommendation Next apply for challenge of evaluation 				
Note : All applications to be made to COE along with the payment of the prescribed fee.						

Table 11: Grievance Redressal Mechanism

Challenge of Evaluation – Flow Process

Table 12 : Evaluation – Flow Process

Step 1	A student can make an appeal to the CoE for the review of answer scripts after paying the prescribed fee.
Step 2	CoE will issue the photocopy of answer scripts to the student.
Step 3	The faculty who had handled the subject will evaluate the script and HoD will recommend.
Step 4	A committee consisting of 2 evaluators appointed by CoE will review and declare the result.
Step 5	If the result is in favour of the student, the fee collected will be refunded to the student.
Step 6	The final mark will be announced by CoE.

16. LETTER GRADE

Absolute grading system is adopted in converting marks to grads.

16.1 Absolute Grading Policy

All assessments of a course will be evaluated on absolute marks basis. However, for the purpose of reporting the performance of a candidate, letter grades, each carrying certain number of points, will be awarded as per the range of total marks (out of 100) obtained by the candidate in each subject as detailed below :

Table 1	3: Absolute	Grading -	Letter Gra	ade and its	Range
			TODE		1

SI.No.	Range of percentage of total marks	Letter Grade	Grade Points
1.	91 - 100	O (Outstanding)	10
2.	81 – 90	A+ (Excellent)	9
3.	71 – 80	A (Very Good)	8
4.	61 – 70	B+ (Good)	7
5.	50 – 60	B (Average)	6
6.	<50	<50 RA (Re-appearance)	
7.	Shortage of attendance	RA - SA (Re-appearance due to shortage of attendance)	0
8.	Absent	RA – AB (Re-appearance due to absence)	0

9.	Withdrawal from examination	W	0
10.	Pass in Mandatory non-credit courses	Р	0
11.	Fail in Mandatory non-credit courses	F	0

A student is deemed to have passed and acquired the corresponding credits in a particular course if he/she obtains any one of the following grades: "O", "A+", "A", "B+", "B". 'RA' indicates that Reappearance is mandatory for that course concerned. 'SA' denotes shortage of attendance (as per Clause 9) and hence prevented from writing the End Semester Examination. P and F are grades for mandatory, but non-credit courses.

16.2 Grading for Mandatory Courses

Mandatory Courses are courses that are required to be completed to fulfill the degree requirements (e.g. Human excellence, Environmental science, etc.). They are normally non – credit based. These courses will not be taken in to consideration for the SGPA / CGPA calculations. Each of these courses is assessed continuously and internally for a total mark of 100. The pass mark is 50%. Students, who fail to pass this course, are required to repeat the course, when offered next.

- **16.2.1** For Mandatory non-credit courses the student must satisfy the minimum attendance requirement & passing criteria as specified for the course. These courses do not carry credits but needs to be completed to fulfill the degree requirements.
- **16.2.2** For the Mandatory non-credit courses student completing the course will be awarded Pass grade (P) and those who fail to satisfy the attendance requirement or fail to satisfy the minimum passing requirement of 50% marks, will be awarded Fail (F) grade and the student must re-register for the course when it is offered next.

16.3 Formula for SGPA and CGPA calculations

After the results are declared, grade sheets will be issued to each student, which will contain the following details :

- O The College Name and Affiliating University.
- () The list of courses registered during the semester and the grades scored.
- () The Semester Grade Point Average (SGPA) for the semester.
- O The Cumulative Grade Point Average (CGPA) of all courses enrolled from first semester onwards.

On completion of a semester, each student is assigned a Semester Grade Point Average which is computed as below for all courses registered for, by the student during that semester.

Semester Grade Point Average = $\frac{\sum (C_i \times GP_i)}{\sum C_i}$

where C_i is the credit for a course in that semester and GP_i is the Grade Point earned by the student for that course. The **SGPA** is rounded off to two decimals.

The overall performance of a student at any stage of the Degree programme is evaluated by the **C**umulative **G**rade **P**oint **A**verage **(CGPA)** up to that point of time

Cumulative Grade Point Average =
$$\frac{\sum (C_i \times GP_i)}{\sum C_i}$$

where C_i is the credit for each course in each of the completed semesters at that stage and GP_i is the grade point earned by the student for that course. The CGPA is rounded off to two decimals.

16.4 Formula For Calculating Percentage

 $CGPA \times 10 = \%$ of Marks

17. ELIGIBILITY FOR THE AWARD OF DEGREE

A student shall be declared to be eligible for the award of the B.E. / B.Tech. Degree provided the student has

- i. Successfully gained the required number of total credits as specified in the curriculum corresponding to the student's programme within the stipulated time.
- ii. Successfully completed the course requirements, appeared for the End Semester examinations and passed all the subjects prescribed in clause no.7.
- iii. Successfully passed any additional courses prescribed by the Academic council
- iv. Successfully passed any additional courses prescribed by the Department & concerned whenever readmitted under regulations 2019. (R19) (vide Clause 4.2)
- v. No disciplinary action pending against the student.
- vi. The award of Degree must have been approved by the Academic Council of KIT.

18. CLASSIFICATION OF M.E / MBA / MCA DEGREE

The degree awarded to eligible students will be classified as given in Table 14.

Table 14: Classification of the ME/MBA/MCA Degree

SI.No.	Class Awarded	Criteria	
1.	First class with distinction	A student who satisfies the following conditions shall be declared	
		to have passed the examination in First class with Distinction :	
		M.E. / M.B.A.	
		Should have passed the examination in all the courses of all	
		the four semesters in the student's First Appearance within	
		three years, which includes authorised break of study of one	
		year (if availed). Withdrawal from examination will not be	
		considered as an appearance.	
		Should have secured a CGPA of not less than 8.50 .	
		Should NOT have been prevented from writing end Semester	
		examination due to lack of attendance in any of the courses.	

		M.C.A		
		 Should have passed the examination in all the courses of all the six semesters in the student's First Appearance within four years, which includes authorised break of study of one year (if availed). Withdrawal from examination will not be considered as an appearance. Should have secured a CGPA of not less than 8.50. Should NOT have been prevented from writing end Semester examination due to lack of attendance in any of the courses. 		
2.	First Class	A student who satisfies the following conditions shall be declared to have passed the examination in First class :		
		M.E. / M.Tech. / M.B.A.		
		Should have passed the examination in all the courses of		
		all four semesters within three years, which includes one		
		year of authorized break of study (if availed) or prevention		
	Ó	from writing the End Semester Examination due to lack of		
	~	Should have secured a CGPA of not less than 7 00		
	Ш I	 Should have secured a CGPA of not less than 7.00. M C A 		
		Should have passed the examination in all the courses of		
	E E	all six semesters within four years, which includes one		
	U.	year of authorized break of study (if availed) or prevention		
	4	from writing the End Semester Examination due to lack of		
		attendance (if applicable).		
		Should have secured a CGPA of not less than 7.00 .		
3.	Second Class	All other students (not covered in clauses SI.No.1 and 2 under		
		clause 19) who qualify for the award of the degree (vide Clause		
		20) shall be declared to have passed the examination in Second		
		Class.		

Note : A student who is absent for the End Semester Examination in a course / project work Viva Voce after having registered for the same will be considered to have appeared for that examination (except approved withdrawal from End Semester Examinations as per Clause 9) for the purpose of classification.

19. AWARD OF DEGREE

The Academic Council of the institution will approve the award of Degree to all eligible students. The degree will be issued by Anna University, Chennai and the consolidated Grade Sheet will be issued by the institution. The consolidated grade sheet will specify any specializations and distinctions that the student has earned during the course of the study.

20. FACULTY MENTOR

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To help the students in palnning their courses of study and for general advice on the academic progarmme, the Head of the Department will attach a certain number of students (maximum 20) to a faculty member of the department. He/She shall function as Faculty Mentor for these students throughout their period of study. The faculty mentor shall,

- O Advice the students in registering and reappearance registering of courses
- () Monitor their attendance, academic progress and discipline of the students
- O Counsel periodically or during the faculty mentor meeting scheduled in the class time table.
- () Inform the students about the various facilities and activities available to enhance the student's curricular and co-curricular activities.
- If necessary, the faculty mentor may also discuss with or inform the parents about the progress of the students through Head of the Department or in Parent-Teacher meeting.

21. CLASS COMMITTEE

The objective of the Class Committee is to improve the teaching-learning process.

The functions of the class committee include :

- O Resolving difficulties experienced by students in the classroom and in the laboratories.
- O Clarifying the regulations of the degree programme and the details of rules therein.
- Discussing the progress of academic schedule and deviations if any.
- S Evaluating the performance of the students of the class after each test and finding the ways and means of improvement.
- Every class in first year of study shall have a class committee consisting of faculty members who are teaching in that class, student representatives (cross section of students from boys and girls) and a chairperson who is a faculty not handling the course for the class.
- From III semester onwards, Class committee comprises of all the faculty members who are handling courses in that particular semester and two student representatives from each course. A chairperson who is a faculty not handling course for that particular semester, nominated by the Head of the Department shall coordinate the activities of this committee.
- The class committee shall be constituted by the Head of the Department/Chief Tutor on the first week of commencement of the semester.
- () The class committee shall meet three times in a semester as specified in the academic calendar.
- () The Principal may participate in any class committee of the institution.
- Ouring these meetings, the representative of the class shall meaningfully interact and express the opinions and suggestions of the other students of the class to improve the effectiveness of the teaching-learning process.
- The Chairperson is required to prepare the minutes of the meeting, signed by the members and submit the same to Head of the Department within five working days of the meeting. Head of the Department will in turn consolidate and forward the same to the Principal, within 10 working days of the meeting.
- In each meeting, the action taken report of the previous meeting is to be presented by the Chairperson of the class committee.

22. COMMON COURSE COMMITTEE

- A theory course handled by more than one teacher shall have a "Common Course Committee" comprising of all teachers teaching that course and few students who have registered for that course. There shall be two student representatives from each batch of that course. One of the teachers shall be nominated as Course Coordinator by the HoD concerned and duly approved by the Principal
- The first meeting of the Common Course Committee shall be held within fifteen days from the date of commencement of the semester. The nature and weightage of the continuous assessments shall be decided in the first meeting, within the framework of the Regulations. Two or three subsequent meetings in a semester may be held at suitable intervals. During these meetings, the student members shall meaningfully interact and express their opinions and suggestions of all the students to improve the effectiveness of the teaching-learning process. It is the responsibility of the student representatives to convey the proceedings of these meetings to the whole batch.
- In addition, the "Common Course Committee" (without the student representatives) shall meet to ensure uniform evaluation of continuous assessments after arriving at a common scheme of evaluation for the assessments.
- Wherever feasible, the common course committee (without the student representatives) shall also prepare a common question paper for the continuous assessment tests. The question paper for the end semester examination is common and shall be set by the Course Coordinator in consultation with all the teachers or the external member as appointed by the Controller of Examinations.

23. DETAILS OF FACULTY PEDAGOGICAL AND STUDENT ASSESSMENT RECORD

Every teacher is required to maintain a Faculty Record Book/ course file consisting of the following details as shown below;

- () Time-table, course syllabus, program outcomes, course outcomes.
- Details of attendance of each student marked in each theory/practical/project work class.
- O CIA marks, Midsem marks, Details of Assignment/ seminar given, course delivery details, corrective and preventive actions on test performance of students and any other additional details.

The record book should be submitted to the HOD periodically (at least three times in a semester) for checking the syllabus covered, the test marks and attendance. The HOD shall put his/her signature and date in the record book after due verification. At the end of the semester, the record book shall be verified by the Principal who will also ensure safe custody of the document for at least four years. The university or any inspection team appointed by the University / UGC / AICTE may verify the records of attendance and assessment of both current and previous semesters.

24. DISCIPLINE

Every student is required to maintain discipline and decorum both inside and outside the institution campus. They shall follow all the rules and regulations and should not indulge in any

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activity which can tarnish the reputation of the University or Institution. The Principal shall refer any act of indiscipline by students to the Discipline and Welfare Committee and other appropriate committees for action.

25. REVISION OF REGULATIONS AND CURRICULUM

The institution may from time to time revise, amend or change the Regulations, scheme of Examinations and syllabi, if found necessary. Academic Council assisted by Board of Studies and Standing Committee will make such revisions / changes.

Note : Any ambiguity in interpretation of this regulation is to be put up to the Standing Committee, whose decision will be final.

26. SPECIAL CASES

Department Code

VD - VLSI Design

MA - Mathematics

EN - English

AE - Applied Electronics

ED - Engineering Design

CA - Computer Application

MB - Management Studies

CE - Career Enhancement MC - Mandatory Course

PS - Power System Engineering

CS - Computer Science and Engineering

In the event of any clarification in the interpretation of the above rules and relations, they shall be referred to the Standing Committee. The standing committee will offer suitable interpretations/ clarifications/amendments required for special case on such references and get them ratified in the next meeting of the Academic Council. The decision of the Academic Council is final.

ANNEXURE - I

COURSE NUMBERING SCHEME

	М	1	9	М	Е	Т	7	0	9
	Programme	Regu	lation	Departm	ent Code	Course Type	Semester	Sequence	e Number
Programme :				Course Type					
Masters Degree (M.E. / M.Tech / MBA / MCA) - M			A) - M	T - Theory					
Rea	ulation ·			11		P - Practical / F	Project/ Intern	iship	
R –	19				< 1	E - Elective			

- O Open Elective
- C One Credit Courses
- N Online courses
- S Special Electives

Semester

- 1 First Semester
 - 2 Second Semester
 - 3 Third Semester
 - 4 Fourth Semester
 - 5 Fifth Semester
 - 6 Sixth Semester

Sequence Number

00-99

ANNEXURE - II

POLICY ON MALPRACTICES

GENERAL

- It shall be the endeavour of all concerned to prevent, control and take remedial action to bring about the occurrences of malpractices to "Zero" in Examinations (both Internal and External), Assignments and in all Academic class works.
- O Therefore, a comprehensive approach to the malady of malpractices has to be adopted to create a mindset of integrity and honesty, and at the same time take sufficiently stern action to make it clear that such attempts are fraught with comparably very high risk.
- In keeping with this stance, the following measures are to be taken by all concerned from class room level to the Examination Halls:

A. PREVENTION (This is the best method of tackling this malady)

a. Class room level :

All faculty members are to involve themselves in a psychological growth of students by personal example and self-respect and strive towards

- Developing a sense of honour in the minds of students so that they look down upon earning undeserved marks.
- Imbibing a sense of self-respect and internal dignity that prevents him/her from succumbing to the temptation of easy marks by cheating.
- Generating an awareness of the risks to their character and career if convicted, while also explaining the process and strict rules and regulations adopted by the educational system to prevent malpractices.
- Taking stern view of copied assignments and attempts at malpractices in internal examinations also merits equal seriousness as external examinations.
- Setting sufficiently strong deterrent rules in place and regulations like intimation to parents and warning to students in the presence of parents etc. even in case of efforts at malpractices in internal tests and/or repeated acts despite warnings in case of assignments also.

Examination Halls :

Detailed instructions on Invigilation, question paper setting and evaluation and such other instructions will be issued for Invigilation, vigilance, which are to be brought to the notice of all students prior to the examinations.

B. PENAL ACTION FOR MALPRACTICES

All instances of malpractices will be forwarded to the Principal / Chief Superintendents. The offences will be investigated by a Standing Enquiry Committee constituted by Principal, The committee is to summon and give the student an opportunity to present / plead his/her case. The Committee may also summon anybody else, if it so deems necessary for the conduct of enquiry, in the interest of proper investigation and dispensation of the case. The tenure of the committee would be a complete Academic year.

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The Committee is to be guided by the following :

- S The seriousness of the malpractice, in terms of deviousness, and culpability / criminality of motive.
- S The seriousness in terms of effort and degree of deviousness and culpability / criminality of effort.
- Any FIR / Police case that has been registered in the first instance by the Principal / Chief Superintendent.
- O Any other special consideration either mitigating or to the contrary.

C. PENALTY FOR OFFENSES

The penalties awarded will depend on the seriousness of the Offence. A list of Offences and penalties are placed at Annexure III.

The Enquiry Report with findings and recommendations of the Committee are to be forwarded to the Controller who will undertake necessary follow up action. Based on the recommendations of the Controller of Examinations, the Principal is empowered to award penalties for offences classified as belonging to categories 1 to 7 of the offence table. The cases falling in categories from S.No. 8 onwards are to be put up to the Principal for consideration and award of suitable penalty.

SI.No.	Nature of Malpractice	Maximum Punishment
1.	Appeal by the candidate in the answer script to show mercy by way of awarding more than deserving marks.	RE
2.	The candidate writing his/her name in the answer script.	
3.	The candidate writing his/her registration number/college name in places other than specified in the answer script	
4.	Any special marking in the answer script by the candidate.	Fine of Rs. 1000/- per subject.
5.	The candidate communicating with neighbouring candidate orally or non-verbally; the candidate causing suspicious movement of his/her body.	
6.	Irrelevant writing by the candidate in the answer script.	
7.	The candidate writing answer on his/her question paper or making use of his/her question paper for rough work	

ANNEXURE - III

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8.	The candidate possessing cell phones / programmable calculator(s) / any other electronic storage device(s) gadgets	Invalidating the examination of the particular subject written by the candidate
9.	The candidate possessing cell phones / programmable calculator(s) / any other electronic storage device(s) gadgets	Invalidating the examination of the particular subject written by the candidate
10.	The candidate possessing any incriminating material(s) (whether used or not). For example:-Written or printed materials, bits of papers containing written information, writings on scale, calculator, handkerchief, dress, part of the body, Hall Ticket, etc.	
11.	The candidate possessing cell phone(s)/ programmable calculator(s)/any other electronic storage device(s) gadgets and containing incriminating materials (whether used or not).	Invalidating the examination of the subject concerned and all the theory and the practical subjects of the current semester registered by
12.	The Candidate possessing the question paper of another candidate with additional writing on it.	the candidate. Further the candidate is not considered for revaluation of answer scripts of the arrears-
13.	The candidate passing his/her question paper to another candidate with additional writing on it	subjects. If the candidate has registered for arrears – subjects only, invalidating the examinations
14.	The candidate passing incriminating materials brought into the examination hall in any medium (hard/soft) to other candidate(s).	of all the arrears – subjects registered by the candidate.
15.	The candidate copying from neighbouring candidate.	
16.	The candidate taking out of the examination hall answer booklet(s), used or unused	
17.	Appeal by the candidate in the answer script coupled with a promise of any form of consideration.	
18.	Candidate destroying evidence relating to an alleged irregularity.	Invalidating the examinations of the subject concerned and all the theory and the practical subjects of the current semester registered by the candidate.

		Further the candidate is not considered for
		revaluation of answer scripts of the arrears-
		subiects.
		If the candidate has registered for arrears –
		subjects only invalidating the examinations
		of all the arrears – subjects registered by the
		candidate
		Additional Punishmont :
		i i if the condidate has not completed
		the programme be abe is debarred from
		the programme, ne/sne is departed from
		continuing his/her studies for one year i.e.,
		for two subsequent semesters. However
		the student is permitted to appear for the
		examination in all the arrears-subjects
		during the debarred period.
	REYON	ii. If the candidate has completed the
	4.0-	programme, he/she is prevented from
	CY.	writing the examinations of the arrears-
		subjects for two subsequent semesters
19	Vulgar/offensive writings by the candidate in	
10.	the answer script.	Invalidating the examinations of all the theory
20	The candidate possessing the answer script	and practical subjects of the current semester
20.	of another candidate	and all the arrears -subjects registered by the
	The candidate passing his /her answer script	candidate.
21.	to another candidate	
	Involved in any one or more of the	Invalidating the examinations of all the theory
22.	malpractices of serial no. 8 to 21 for the	and practical subjects of the current semester
	second or subsequent times.	and all the arrears –subjects registered by the
		candidate.
		Additional Punishment :
		i. If the candidate has not completed the
		programme, he/she is debarred from
23.		continuing his/her studies for one year i e
	The candidate substituting an answer book	for two subsequent semesters. However
	let prepared outside the examination hall for	the student is permitted to appear for the
	the one already distributed to the candidate	examination in all the arrears-subjects
		during the debarred period
		ii If the candidate has completed the
		nrogramme he/she is prevented from
		writing the examinations of the arroars
		aubiente for tue aubeequest servester
		subjects for two subsequent semesters.

[1
24.	The candidate indulge in any disruptive conduct including, but not limited to, shouting, assault of invigilator, officials or students using abusive and /or threatening language, destruction of property.	Invalidating the examinations of all the theory and practical subjects of the current semester and all the arrears –subjects registered by the candidate. Additional Punishment :
25.	The candidate harass or engage others to harass on his/her behalf an invigilator, official, witnesses or any other person in relation to an irregularity by making telephone calls, visits, mails or by any other means.	 If the candidate has not completed the programme, he/she is debarred from continuing his/her studies for two years i.e., for four subsequent semesters. However the student is permitted to appear for the examination in all the arrears-subjects
26.	Candidate possessing any firearm/weapon inside the examination hall.	during the debarred period. ii. If the candidate has completed the programme, he/she is prevented from writing the examinations of the arrears -subjects for four subsequent semesters.
27.	Cases of Impersonation	 i. Handing over the impersonator to the police with a complaint to take appropriate action against the person involved in the impersonation by the Chief Supt. If a student of this University is found to impersonate a 'bonafide student', the impersonating student is debarred from continuing his/her studies and writing the examinations permanently. He/she is not eligible for any further admission to any programme of the University. Debarring the 'bonafide student' for whom the impersonation was done from continuing his/her studies and writing the examinations permanently. He/she is not eligible for any further admission to any programme of the University.

ANNEXURE - IV

Process to Consider the Application for Revocation of Detainment

The process to consider the application for revocation of detainment on account of lack of attendance in 3 or more courses, due to genuine reasons (viz. sports participation, NCC, Medical Grounds etc.) is as follows :

The student submits an application for consideration via a request letter to the CoE,not later than 3 days from the last working day, along with the HoD's recommendation, Class Advisor's report and Mentor's recommendation. A committee consisting of the Principal, CoE, HoD (Respective Department) and HoD's-2 from departments other than the student's own. The committee shall meet within 4 working days,to consider the case. Stakeholders may be called to be present in the meeting as may be required, and Decision arrived at. The decision approved by Principal shall be final.

ANNEXURE - V

Academic Evaluation Committee (AEC)

The committee includes the Principal, CoE, HoD concerned. The committee meets to carry out business related to academic matters which require central decision making and approval viz. retest approval of missed CIA, addressing the feedback collected from the various departments' class committee meetings.

Department Evaluation Committee (DEC)

The committee includes HoD (need basis), and a few faculty members of the department from various levels. The committee meets to carry out business related to academic matters that can be addressed within the department viz. course equivalence of common courses for readmitted students; approval of new courses to be offered by the department; consider and approve the credit equivalence of courses offered by industry, review the course offerings; consider the merit of applications involving lack of attendance in PE/OE courses to take up another PE or OE; approve CIAM only courses every semester; approve scheme of assessment for each course; Approval for and Mapping credits of certification courses; approval of list of nationally or internationally recognized professional certification courses with prometric testing.
Curriculum

		Conceptual Fra (For Students admitted from the Academ	nic Year 201	9-20 and onw	ards)		
Semester		Level of Course	Hrs. / Week	No. of Courses	Ran Cree Cou	ge of dits / irses	Total Credits
	•	PART -	I				
A - Foundat	ion C	Courses					
I	Fou	ndation Courses (FC)	4	1		4	4
B - Professi	onal	Core Courses					
I to III	Pro	fessional Core (PC)	3	11	2	-3	31
C - Elective	Cou	rses					
I to III	Pro	fessional Elective (PE)	D ³	5		3	15
D - Project V	Nork						
III & IV	Pro	ject Work (PW)	12 -24	2	6	-12	18
	<u>.</u>	Total Credit		· · · · · · · · · · · · · · · · · · ·			68
		PART II - Career Enhancen	nent Cours	es (CEC)			
II	Arti	cle Writing and Seminar	2	T		1	1
		Total Credit		~			01
		Total Credit to be Earr	ned				69
			~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~			I	

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# Scheme of Instructions and Examinations

(For Students admitted from the Academic Year 2019-20 and onwards)

Semester - I											
			Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Р	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
	Inde	uction	Prograi	nme							
M19MAT101	Applied Mathematics for Electronics Engineers	FC	4	3	0	1	3	40	60	100	4
M19VDT101	Advanced Digital System Design	PC	3	3	0	0	3	40	60	100	3
M19AET101	Advanced Digital Signal Processing	PC	3	3	0	0	3	40	60	100	3
M19AET102	Embedded System Design	PC	3	3	0	0	3	40	60	100	3
M19AET103	Sensors, Actuators and Interface Electronics	РС	3	3	0	0	3	40	60	100	3
	Professional Elective - I	PE	3	3	0	0	3	40	60	100	3
M19AEP101	Electronics System Design Laboratory - I	РС	4	0	4	0	3	40	60	100	2
Т	otal Contact Hours / Week		23	18	04	1	1	otal C	redits		21
	Ш	Seme	ster - II				Ŧ				
			Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19AET201	Soft Computing and Optimization Techniques	РС	3	3	0	0	3	40	60	100	3
M19VDE202	ASIC and FPGA Design	РС	3	3	0	0	3	40	60	100	3
M19VDE303	Hardware-Software Co- Design	РС	3	3	0	0	3	40	60	100	3
M19VDT202	VLSI Signal Processing	PC	3	3	0	0	3	40	60	100	3
	Professional Elective - II	PE	3	3	0	0	3	40	60	100	3
	Professional Elective - III	PE	3	3	0	0	3	40	60	100	3
M19AEP201	Electronics System Design Laboratory – II	PC	4	0	4	0	3	40	60	100	2
M19CEP201	Article Writing and Seminar	CEC	2	0	2	0	-	100	-	100	1

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23

**Total Credits** 

24

Total Contact Hours / Week

18

6

		Seme	ster - III								
			Instru	ction	al Ho	ours		Assess	sment		
Course Code	Course Name	Category	Contact Periods	т	Р	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19AET301	Advanced Microprocessors and Microcontrollers Architecture	РС	3	3	0	0	3	40	60	100	3
	Professional Elective – IV	PE	3	3	0	0	3	40	60	100	3
	Professional Elective – V	PE	3	3	0	0	3	40	60	100	3
M19AEP301	Project Work (Phase I)	PW	12	0	12	0	3	40	60	100	6
т	Total Contact Hours / Week 21 9 12 0 Total Credits								15		
	0.F	Seme	ster - IV	5							
			Instru	ction	al Ho	ours		Assess	sment		

			Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19AEP401	Project Work (Phase II)	PW	24 BATORE	0	24	0	3	40	60	100	12
т	otal Contact Hours / Week		24	0	24	0	7	Fotal C	redits		12

	FOUND	ATION	COURS	SES (	FC)	2	-				
			Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19MAT101	Applied Mathematics for Electronics Engineers	FC	4	3	0	1	3	40	60	100	4
B19ENT201	Professional English	HS	3	3	0	0	3	40	60	100	3

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PROFESSIONAL CORE (PC)											
			Instru	ction	al Ho	ours		Assess	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19VDT101	Advanced Digital System Design	PC	3	3	0	0	3	40	60	100	3
M19AET101	Advanced Digital Signal Processing	РС	3	3	0	0	3	40	60	100	3
M19AET102	Embedded System Design	PC	3	3	0	0	3	40	60	100	3
M19AET103	Sensors, Actuators and Interface Electronics	РС	3	3	0	0	3	40	60	100	3
M19AEP101	Electronics System Design Laboratory - I	РС	4	0	4	0	3	40	60	100	2
M19AET201	Soft Computing and Optimization Techniques	РС	3	3	0	00	3	40	60	100	3
M19VDE202	ASIC and FPGA Design	PC	3	3	0	0	3	40	60	100	3
M19VDE303	Hardware-Software Co- Design	PC	3	3	0	0	3	40	60	100	3
M19AEP201	Electronics System Design Laboratory – II	РС	bat <b>4</b> dre	0	4	0	3	40	60	100	2
M19AET301	Advanced Microprocessors and Microcontrollers Architecture	РС	3	3	0	0	3	40	60	100	3

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PROFESSIONAL ELECTIVES (PE)											
		Seme	ster – I			-					
		Elect	tive – I								
		>	Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19VDT102	CMOS Digital VLSI Design	PE	3	3	0	0	3	40	60	100	3
M19AEE101	Computer Architecture and Parallel Processing	PE	3	3	0	0	3	40	60	100	3
M19AEE102	Electromagnetic Interference and Compatibility	PE	3	3	0	0	3	40	60	100	3
M19AEE103	Neural Networks and Applications	PE	3	3	0	0	3	40	60	100	3
		Seme	ster - II								
	Elective – II										
	Instructional Hours Assessment										
Course Code	Course Name	Category	Contact Periods	т	Ρ	τu	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19VDT104	CAD for VLSI Circuits	PE	3	3	0	0	3	40	60	100	3
M19VDE203	Nano Electronics	PE	3	3	0	0	3	40	60	100	3
M19AEE201	High Performance Networks	PE	- 3	3	0	0	3	40	60	100	3
M19AEE202	Wireless Adhoc and Sensor Networks	PE	3	3	0	0	3	40	60	100	3
		Seme	ster - II								
		Elect	ive – III								
			Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19AEE203	RF System Design	PE	3	3	0	0	3	40	60	100	3
M19AEE204	Speech and Audio Signal Processing	PE	3	3	0	0	3	40	60	100	3
M19VDE201	Device Modelling	PE	3	3	0	0	3	40	60	100	3
M19AEE205	Robotics	PE	3	3	0	0	3	40	60	100	3

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		Seme	ster - III								
		Electi	ve – IV								
			Instru	ction	al Ho	ours	A	Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19AEE301	DSP Processor Architecture and Programming	PE	3	3	0	0	3	40	60	100	3
M19AEE302	Wavelets and Multiresolution Processing	PE	3	3	0	0	3	40	60	100	3
M19VDE204	System on Chip Design	PE	3	3	0	0	3	40	60	100	3
M19VDE302	MEMS and NEMS	PE	3	3	0	0	3	40	60	100	3

Semester - III											
		Elect	ive – V								
		/	Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19VDE304	Solid State Device Modelling and Simulation	PE	3	3	0	0	3	40	60	100	3
M19AEE303	Advanced Digital Image Processing	PE	3	3	0	0	3	40	60	100	3
M19AEE304	Pattern Recognition	PE	bat <b>3</b> dre	3	0	0	3	40	60	100	3
M19AEE305	Secure Computing Systems	PE	3	3	0	0	3	40	60	100	3
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	PRC	JECT	WORK	(PW)		3					
		>	Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Category	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19AEP301	Project Work (Phase I)	PW	12	0	12	0	3	40	60	100	6
M19AEP401	Project Work (Phase II)	PW	24	0	24	0	3	40	60	100	12

CAREER ENHANCEMENT COURSE (CEC)											
		~	Instru	ction	al Ho	ours		Asses	sment		
Course Code	Course Name	Categor	Contact Periods	т	Ρ	TU	Hours of Exam. (ESE)	CIA	ESE	Total	Credit
M19CEP201	Article Writing and Seminar	CEC	2	0	2	0	3	100	-	100	1

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# Semester - I

	M19MAT101 - APPLIED MATHEMATICS FOR	т	Р	ΤU	С
M.E.	ELECTRONICS ENGINEERS				
	(Common to VLSI & AE)	3	0	1	4

	Course Objectives
1.	To demonstrate various analytical skills in applied mathematics and extensive experience with the tactics of problem solving and logical thinking applicable in electronics engineering.
2.	To extend matrix theory in the field of communication engineering.
3.	To understand the basic concepts of probability and random variables to introduce some standard distributions applicable to engineering which can describe real life phenomenon.
4.	To understand the concept of dynamic programming and apply in communication networks.
5.	To understand the basic concepts of Queueing Models and to apply in real life engineering problems.

UNIT - I	FUZZY LOGIC	12
Classical logi	c – Multi valued logics - Fuzzy propositions – Fuzzy quantifiers.	

UNIT - II MATRIX THEORY

12

12

Cholesky decomposition - Generalized Eigenvectors - Canonical basis- QR factorization - Least squares method - Singular value decomposition.

UNIT - III

# PROBABILITY AND RANDOM VARIABLES

Probability - Axioms of probability - Conditional probability - Random variables - Probability function - Moments - Moment generating functions and their properties - Binomial, Poisson, Geometric, Uniform, Exponential and Normal distributions.

UNIT - IV	DYNAMIC PROGRAMMING	12		
Dynamic programming - Principle of optimality - Forward and backward recursion - Applications of dynamic				
programming: Shortest distance Problem in communication networks - Problems of dimensionality.				

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UNIT - V

LAPLACE TRANSFORMS

12

Existence conditions - Properties (excluding proofs) - Transform of standard functions - Transforms of derivatives and integrals - Periodic function – Inverse Laplace transform - Applications to solution of linear second order ordinary differential equations with constant coefficients.

# **Total Instructional hours : 60**

	Course Outcomes
CO1	Make use of Eigen values and Eigen vectors to reduce the quadratic form into canonical form and to find the powers of a square matrix.
CO2	Determine solution for maxima and minima problems.
CO3	Solve differential equations which existing in different engineering disciplines.
CO4	Develop the applications of differential equations in various engineering field.
CO5	Apply Laplace transform and inverse transform to solve differential equations with constant coefficients.

	Reference Books
1.	Bronson, R., "Matrix Operations", Schaum's Outline Series, (McGraw Hill), 2 nd Edition, 2011.
2.	George, J. Klir. and Yuan, B., "Fuzzy sets and Fuzzy logic Theory and Applications", (Pearson Education, India), 1 st Edition, 2015.
3.	Gross, D., Shortle J. F., Thompson, J.M., and Harris, C. M., "Fundamentals of Queueing Theory", (John Wiley), 4 th Edition, 2014.
4.	Johnson, R.A., Miller, I and Freund J., "Miller and Freund's Probability and Statistics for Engineers", (Pearson Education, Asia), 8 th Edition, 2015.
5.	Taha, H.A., "Operations Research: An Introduction", (Pearson education, Asia), New Delhi, 9 th Edition, 2016.

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M.E		M19VDT101 - ADVANCED DIGITAL SYSTEM DESIGN	Т	Р	TU	С
		(Common to VLSI & AE)	3	0	0	3
		Course Objectives				
1.	To int	roduce methods to analyze and design synchronous sequenti	al circu	its.		
2.	To int	roduce methods to analyze and design asynchronous sequen	tial circ	uits.		
3.	To int	roduce fault diagnosis and testing algorithms.				
4.	To int	roduce the architectures of programmable devices.				
5.	To int	roduce design and implementation of digital circuits using prog	grammi	ng tools	6.	
UNI	T - I	SEQUENTIAL CIRCUIT DESIGN				9
Analys	sis of c	locked synchronous sequential circuits and modeling- State	diagra	m, stat	e table,	state
table a	assignr	nent and reduction-Design of synchronous sequential circuits	s desigi	n of iter	ative ci	rcuits-
ASM o	chart a	nd realization using ASM.				
UNIT	Г- II	ASYNCHRONOUS SEQUENTIAL CIRCUIT D	ESIGN			9
Analys	sis of a	synchronous sequential circuit – flow table reduction-races-	state a	ssignme	ent- trar	nsition
table a	and pro	oblems in transition table- design of asynchronous sequential	circuit-	Static,	dynami	ic and
essen	tial haz	zards - data synchronizers - mixed operating mode asynch	ironous	circuits	s – des	igning
vendir	ng mac	hine controller.				
UNIT	UNIT - III FAULT DIAGNOSIS AND TESTABILITY ALGORITHMS 9				9	
Fault	table n	nethod-path sensitization method – Boolean difference meth	nod-D a	lgorithn	n - Tole	rance
techni	ques –	The compact algorithm - Fault in PLA - Test generation-DFT	schem	es – Bu	ilt in sel	f-test.
UNIT	- IV	SYNCHRONOUS DESIGN USING PROGRAMMABL	E DEV	ICES		9
Progra	amming	g logic device families – Designing a synchronous sequent	ial circu	uit usin	g PLA/F	PAL –
Realiz	ation o	f finite state machine using PLD – FPGA – Xilinx FPGA-Xilinx	4000.			
UNIT	r - V	SYSTEM DESIGN USING VERILOG				9
Hardw	vare M	odelling with Verilog HDL – Logic System, Data Types and	Operat	ors For	Modell	ing in
Verilog HDL - Behavioural Descriptions in Verilog HDL – HDL Based Synthesis – Synthesis of Finite State						
Machines- structural modeling - compilation and simulation of Verilog code - Test bench - Realization of						
combi	nationa	al and sequential circuits using Verilog – Registers – counters –	- seque	ntial ma	ichine –	serial
adder – Multiplier- Divider – Design of simple microprocessor.						
		Το	tal Inst	ruction	al hour	s : 45
						0

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	Course Outcomes : Students will be able to		
CO1	Analyze and design synchronous sequential digital circuits.		
CO2	Analyze and design asynchronous sequential digital circuits.		
CO3	Design fault diagnosis system for testing various faults.		
CO4	Identify the programmable devices for system design.		
CO5	Design and implement digital circuits of industry standards by using programming tools.		

	Reference Books
1.	Charles H.Roth Jr, "Fundamentals of Logic Design", Thomson Learning, 2004.
2.	M.D.Ciletti, "Modeling, Synthesis and Rapid Prototyping with the Verilog HDL", Prentice Hall, 1999.
3.	M.G.Arnold, "Verilog Digital – Computer Design", Prentice Hall (PTR), 1999.
4.	Nripendra N Biswas, "Logic Design Theory", Prentice Hall of India, 2001.
5.	Parag K.Lala, "Fault Tolerant and Fault Testable Hardware Design", B S Publications, 2002.
6.	Parag K.Lala, "Digital system Design using PLD", B S Publications, 2003.
7.	S. Palnitkar, "Verilog HDL – A Guide to Digital Design and Synthesis", Pearson, 2003.



	M19AET101 ADVANCED DIGITAL SIGNAL PROCESSING	Т	Ρ	TU	С
IVI.C.	MISAET INT- ADVANCED DIGITAL SIGNAL PROCESSING	3	0	0	3

Course Objectives		
1.	To comprehends mathematical description and modelling of discrete time random signals.	
2.	To conversant with important theorems and algorithms.	
3.	To learns relevant figures of merit such as power, energy, bias and consistency.	
4.	To learns about Adaptive filters.	
5.	To familiar with estimation, equalization and filtering concepts.	

### UNIT - I DISCRETE RANDOM SIGNAL PROCESSING

Wide sense stationary process – Ergodic process – Mean – Variance - Auto-correlation and Autocorrelation matrix - Properties - Weiner Khitchine relation - Power spectral density – filtering random process, Spectral Factorization Theorem–Finite Data records, Simulation of uniformly distributed/ Gaussian distributed white noise – Simulation of Sine wave mixed with Additive White Gaussian Noise.

### UNIT - II

#### SPECTRUM ESTIMATION

Bias and Consistency of estimators - Non-Parametric methods - Correlation method - Co- variance estimator - Performance analysis of estimators – Unbiased consistent estimators - Periodogram estimator - Barlett spectrum estimation - Welch estimation.

UNIT - III

# LINEAR ESTIMATION AND PREDICTION

Model based approach - AR, MA, ARMA Signal modeling - Parameter estimation using Yule-Walker method - Maximum likelihood criterion - Efficiency of estimator - Least mean squared error criterion – Wiener filter - Discrete Wiener Hoff equations – Mean square error.

# UNIT - IV

#### **ADAPTIVE FILTERS**

Recursive estimators - Kalman filter - Linear prediction – Forward prediction and Backward prediction, Prediction error - Whitening filter, Inverse filter - Levinson recursion, Lattice realization, Levinson recursion algorithm for solving Toeplitz system of equations.

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UNIT - V

MULTIRATE DIGITAL SIGNAL PROCESSING

FIR Adaptive filters - Newton's steepest descent method - Adaptive filters based on steepest descent method - Widrow Hoff LMS Adaptive algorithm - Adaptive channel equalization - Adaptive echo canceller - Adaptive noise cancellation - RLS Adaptive filters - Exponentially weighted RLS – Sliding window RLS - Simplified IIR LMS Adaptive filter.

## **Total Instructional hours : 45**

Course Outcomes : Students will be able to		
CO1	Outline various properties of random process.	
CO2	Explain various spectrum estimation methods.	
CO3	Explain various linear estimation and prediction methods.	
CO4	Design various prediction systems for adaptive filters.	
CO5	Design models for adaptive equalization and filtering.	

	Reference Books
1.	John G. Proakis, Dimitris G. Manolakis, "Digital Signal Processing", Prentice Hall of India, New Delhi, 2005.
2.	Monson H. Hayes, "Statistical Digital Signal Processing and Modeling", John Wiley and Sons Inc., New York, 2006.
3.	P. P. Vaidyanathan, "Multirate Systems and Filter Banks", Prentice Hall, 1992.
4.	S. Kay, "Modern spectrum Estimation theory and application", Prentice Hall, Englehood Cliffs, 1988.
5.	Simon Haykin, "Adaptive Filter Theory", Prentice Hall, Englehood Cliffs, 1986.
6.	Sophoncles J. Orfanidis, "Optimum Signal Processing", McGraw-Hill, 2000.

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M.E.	M19AET102 - EMBEDDED SYSTEM DESIGN	т	Ρ	TU	С
	(Common to AE and VLSI)	3	0	0	3

Course Objectives		
1.	To introduce the overview, design metrics and methodology of embedded systems.	
2.	To introduce architecture of single purpose processor.	
3.	To understand various protocols of embedded system.	
4.	To understand the State machine models.	
5.	To introduce software development tools.	

# UNIT - I EMBEDDED SYSTEM OVERVIEW

Embedded System Overview, Design Challenges – Optimizing Design Metrics, Design Methodology, RT-Level Combinational and Sequential Components, Optimizing Custom Single-Purpose Processors.

# UNIT - II GENERAL AND SINGLE PURPOSE PROCESSOR

Basic Architecture, Pipelining, Superscalar and VLIW architectures, Programmer's view, Development Environment, Application-Specific Instruction-Set Processors (ASIPs) Microcontrollers, Timers, Counters and watchdog Timer, UART, LCD Controllers and Analog-to-Digital Converters, Memory Concepts.

UNIT - III	BUS STRUCTURES
	DOS STRUCTURES

Basic Protocol Concepts, Microprocessor Interfacing – I/O Addressing, Port and Bus-Based I/O, Arbitration, Serial Protocols, I2C, CAN and USB, Parallel Protocols – PCI and ARM Bus, Wireless Protocols – IrDA, Bluetooth, IEEE 802.11.

# UNIT - IV STATE MACHINE AND CONCURRENT PROCESS MODELS

Basic State Machine Model, Finite-State Machine with Data path Model, Capturing State Machine in Sequential Programming Language, Program-State Machine Model, Concurrent Process Model, Communication among Processes, Synchronization among processes, Dataflow Model, Real-: Hardware/Software Co-Simulation, Reuse: Intellectual Property Cores, Design Process Models.

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#### UNIT - V EMBEDDED SOFTWARE DEVELOPMENT TOOLS AND RTOS

Compilation Process – Libraries – Porting kernels – C extensions for embedded systems – emulation and debugging techniques – RTOS – System design using RTOS.

# **Total Instructional hours : 45**

	Course Outcomes : Students will be able to		
CO1	Explain the design challenges and basic metrics of embedded system.		
CO2	Explain the architecture and pipelining process.		
CO3	Analyse different protocols.		
CO4	Examine the state machine and design process models.		
CO5	Outline embedded software development tools and RTOS.		

	Reference Books		
1.	Bruce Powel Douglas, "Real time UML, second edition: Developing efficient objects for embedded systems", Pearson Education, 3 rd Edition, 1999.		
2.	Daniel W. Lewis, "Fundamentals of embedded software where C and assembly meet", Pearson Education, 2002.		
3.	Frank Vahid and Tony Gwargie, "Embedded System Design", John Wiley & sons, 2002.		
4.	Steve Heath, "Embedded System Design", Elsevier, Second Edition, 2004.		



M.E.	M19AET103 - SENSORS, ACTUATORS AND	Т	Ρ	TU	С
	INTERFACE ELECTRONICS	3	0	0	3

Course Objectives		
1.	To understand static and dynamic characteristics of measurement systems.	
2.	To study various types of sensors.	
3.	To study various types of Amplifiers.	
4.	To study different types of actuators.	
5.	To study State-of-the-art digital and semiconductor sensors.	

UNIT - I

#### INTRODUCTION TO MEASUREMENT SYSTEMS

Introduction to measurement systems: general concepts and terminology, measurement systems, sensor classification, general input-output configuration, methods of correction, performance characteristics: static characteristics of measurement systems, accuracy, precision, sensitivity, other characteristics: linearity, resolution, systematic errors, random errors, dynamic characteristics of measurement systems: zero-order, first-order, and second-order measurement systems and response.

#### UNIT - II

#### **RESISTIVE AND REACTIVE SENSORS**

Resistive sensors: potentiometers, strain gages, resistive temperature detectors, magneto resistors, light-dependent resistors, Signal conditioning for resistive sensors: Wheatstone bridge, sensor bridge calibration and compensation, Instrumentation amplifiers, sources of interference and interference reduction, Reactance variation and electromagnetic sensors, capacitive sensors, differential, inductive sensors, linear variable differential transformers (LVDT), magneto elastic sensors, hall effect sensors, Signal conditioning for reactance- based sensors & application to the LVDT.

#### UNIT - III

#### **SELF - GENERATING SENSORS**

Self-generating sensors: thermoelectric sensors, piezoelectric sensors, pyroelectric sensors, photovoltaic sensors, electrochemical sensors, Signal conditioning for self- generating sensors: chopper and low - drift amplifiers, offset and drifts amplifiers, electrometer amplifiers, charge amplifiers, noise in amplifiers.

# UNIT - IV

# ACTUATORS DRIVE CHARACTERISTICS AND APPLICATIONS

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Relays, Solenoid drive, Stepper Motors, Voice-Coil actuators, Servo Motors, DC motors and motor control, 4-to-20 mA Drive, Hydraulic actuators, variable transformers: synchro's, resolvers, Inductosyn, resolver-to-digital and digital-to-resolver converters.

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#### UNIT - V DIGITAL SENSORS AND SEMICONDUCTOR DEVICE SENSORS

Digital sensors : position encoders, variable frequency sensors – quartz digital thermometer, vibrating wire strain gages, vibrating cylinder sensors, saw sensors, digital flow meters, Sensors based on semiconductor junctions: thermometers based on semiconductor junctions, magneto diodes and magneto transistors, photodiodes and phototransistors, sensors based on MOSFET transistors, CCD imaging sensors, ultrasonic sensors, fiber- optic sensors.

### **Total Instructional hours : 45**

	Course Outcomes : Students will be able to		
CO1	Outline the concepts of measurement systems.		
CO2	Explain the resistive and reactive sensors.		
CO3	Explain the self-generating sensors.		
CO4	Analyze the characteristics of actuators.		
CO5	Examine about digital and semiconductor sensors.		

Reference	Boo	ks
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1.	Andrzej M. Pawlak, "Sensors and Actuators in Mechatronics Design and Applications", 2006.
2.	D. Johnson, "Process Control Instrumentation Technology", John Wiley and Sons. D.Patranabis, "Sensors and Transducers", TMH, 2003. IMBATORE
3.	E.O. Doeblin, "Measurement System: Applications and Design", McGraw Hill publications.
4.	Graham Brooker, "Introduction to Sensors for ranging and imaging", Yesdee, 2009.
5.	Herman K.P. Neubrat, "Instrument Transducers – An Introduction to Their Performance and Design", Oxford University Press.
6.	Lan Sinclair, "Sensors and Transducers", Elsevier, 3rd Edition, 2011.
7.	Jon Wilson, "Sensor Technology Handbook", New one, 2004.
8.	Kevin James, "PC Interfacing and Data acquisition", Elsevier, 2011.
9.	Ramon Pallás Areny, John G. Webster, "Sensors and Signal conditioning", 2 nd Edition, John Wiley and Sons, 2000.
10.	Clarence W. de Silva, "Sensors and Actuators: Control System Instrumentation", CRC Press, 2007.

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M.E	M19AEP101 - ELECTRONICS SYSTEM DESIGN LABORATORY - I	т	Р	TU	С
		0	4	0	2
Course Objectives					
4	To study of different interfeese				

1.	To study of different interfaces.
2.	To learn asynchronous and clocked synchronous sequential circuits.
3.	To understand the concept of built in self-test and fault diagnosis.

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Expt. No.	Description of the Experiments
1.	System design using PIC, MSP430, 51 Microcontroller and 16-bit Microprocessor - 8086.
2.	Study of different interfaces (using embedded microcontroller).
3.	Implementation of Adaptive Filters and multistage multirate system in DSP Processor.
4.	Simulation of QMF using Simulation Packages.
5.	Analysis of Asynchronous and clocked synchronous sequential circuits.
6.	Built in self-test and fault diagnosis.
7.	Sensor design using simulation tools.
8.	Design and analysis of real time signal processing system – Data acquisition and signal processing.

**Total Instructional hours : 60** 

	Course Outcomes : Students will be able to	
CO1	Apply PIC, MSP430, 51 Microcontroller and 8086 for system design.	
CO2	Examine the simulation of QMF.	
CO3	Design sensor using simulation tools.	
CO4	Design and analyse of real time signal processing system.	
CO5	Design and analyse the data acquisition system.	

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List of Equipment Required		
SI. No.	Name of the Equipment	Quantity
1.	Desktop computer	25
2.	PIC 16 XXX / 18 XXX Microcontroller development system with relevant IDE, interfacing hardware like matrix key pad, seven segment display, LCD module, point LED, switches, I2C based RTC and EPROM, temperature sensor, buzzer etc and programming facility	5
3.	MSP430 Microcontroller development system with relevant IDE, interfacing hardware like matrix key pad, seven segment display, LCD module, point LED, switches, I2C based RTC and EPROM, temperature sensor, buzzer etc and programming facility /ARM Processor	5
4.	8051 Microcontroller development system with relevant IDE, interfacing hardware like matrix key pad, seven segment display, LCD module, point LED, switches, I2C based RTC and EPROM, temperature sensor, buzzer etc and programming facility	5
5.	8086 Development trainer with basic interfacing modules	5
6.	TMS320C XXXX DSP based Development trainer	5

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# **Professional Elective - I**

ME	M19VDT102 - CMOS DIGITAL VLSI DESIGN	Т	Р	TU	С
WI.E.	(Common to VLSI & AE)	3	0	0	3

1. To introduce the principle of operation of CMOS inverter.	
2. To study the concept of combinational logic circuits.	
3. To study the concept of sequential logic circuits.	
4. To introduce the architectures of VLSI system.	
5. To learn about the interconnect and clocking process.	

# UNIT - I MOS TRANSISTOR PRINCIPLES AND CMOS INVERTER

MOS (FET) Transistor Characteristic under Static and Dynamic Conditions, MOS Transistor Secondary Effects, Process Variations, Technology Scaling, Internet Parameter and electrical wise models CMOS Inverter - Static Characteristic, Dynamic Characteristic, Power, Energy, and Energy Delay parameters.

#### UNIT - II

UNIT - III

#### **COMBINATIONAL LOGIC CIRCUITS**

Propagation Delays, Stick diagram, Layout diagrams, Examples of combinational logic design, Elmore's constant, Dynamic Logic Gates, Pass Transistor Logic, Power Dissipation, Low Power Design principles.

#### SEQUENTIAL LOGIC CIRCUITS

Static Latches and Registers, Dynamic Latches and Registers, Timing Issues, Pipelines, Pulse and sense amplifier based Registers, Nonstable Sequential Circuits.

#### UNIT - IV ARITHMETIC BUILDING BLOCKS AND MEMORY ARCHITECTURES

Data path circuits, Architectures for Adders, Accumulators, Multipliers, Barrel Shifters, Speed and Area Tradeoffs, Memory Architectures, and Memory control circuits.

# UNIT - V INTERCONNECT AND CLOCKING STRATEGIES

Interconnect Parameters – Capacitance, Resistance, and Inductance, Electrical Wire Models, Timing classification of Digital Systems, Synchronous Design and Self – Timed Circuit Design.

# **Total Instructional hours : 45**

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	Course Outcomes : Students will be able to	
CO1	Outline the concept and working of CMOS inverter.	
CO2	Explain the process of combinational design.	
CO3	Explain the Latches and registers.	
CO4	Analyze the arithmetic building blocks and memory architecture.	
CO5	Outline the concept of interconnect and clocking.	

# Reference Books

1.	Jan Rabaey, Anantha Chandrakasan, B Nikolic, "Digital Integrated Circuits: A Design Perspective", Prentice Hall of India, Second Edition, 2003.
2.	Jacob Baker "CMOS: Circuit Design, Layout, and Simulation, Third Edition", Wiley IEEE Press, 3 rd Edition, 2010.
3.	M J Smith, "Application Specific Integrated Circuits", Addisson Wesley, 1997.
4.	N.Weste, K. Eshraghian, "Principles of CMOS VLSI Design", Addision Wesley, Second Edition, 1993.



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	M19AEE101 - COMPUTER ARCHITECTURE	т	Ρ	TU	С
M.E.	AND PARALLEL PROCESSING (Common to AE & VLSI)	3	0	0	3
	Course Objectives				

1.	To study various types of processor architectures and the importance of scalable architectures.
2.	To introduce parallel processing and pipelining.
3.	To learn about the memory hierarchy.
4.	To study the multiprocessor architecture.
5.	To study the multicore architecture.

UNIT - I	COMPUTER DESIGN AND PERFORMANCE MEASURES	9
		1

Fundamentals of Computer Design – Parallel and Scalable Architectures – Multiprocessors – Multi-vector and SIMD architectures – Multithreaded architectures – Stanford Dash multiprocessor – KSR1 - Data-flow architectures - Performance Measures.

#### UNIT - II

# PARALLEL PROCESSING, PIPELINING AND ILP

Instruction Level Parallelism and Its Exploitation - Concepts and Challenges - Pipelining processors -Overcoming Data Hazards with Dynamic Scheduling – Dynamic Branch Prediction - Speculation -Multiple Issue Processors - Performance and Efficiency in Advanced Multiple Issue Processors.

#### UNIT - III

#### MEMORY HIERARCHY DESIGN

Memory Hierarchy - Meemory Technology and Optimizations – Cache memory – Optimizations of Cach Performance – Memory Protection and Virtual Memory - Design of Memory Hierarchies.

# UNIT - IV

# MULTIPROCESSORS

Symmetric and distributed shared memory architectures – Cache coherence issues – Performance Issues – Synchronization issues – Models of Memory Consistency - Interconnection networks – Buses, crossbar and multi-stage switches.

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UNIT - V

## **MULTI-CORE ARCHITECTURES**

Software and hardware multithreading – SMT and CMP architectures – Design issues – Case-studies – Intel Multi-core architecture – SUN CMP architecture – IBM cell architecture – hp architecture.

## Total Instructional hours : 45

	Course Outcomes : Students will be able to	
CO1	Explain the multiprocessors and its performance measure.	
CO2	Explain the concept of parallel processing and pipelining.	
CO3	Analyze about the memory hierarchy design.	
CO4	Outline the issues related to multiprocessors.	
CO5	Compare multicore architectures.	

Reference	Books

1.	David E. Culler, Jaswinder Pal Singh, "Parallel Computing Architecture: A hardware/ software approach", Morgan Kaufmann / Elsevier, 1997.
2.	Dimitrios Soudris, Axel Jantsch, "Scalable Multi-core Architectures : Design Methodologies and Tools", Springer, 2012.
3.	Hwang Briggs, "Computer Architecture and parallel processing", McGraw Hill, 1984.
4.	John L. Hennessey and David A. Patterson, "Computer Architecture – A quantitative approach", Morgan Kaufmann / Elsevier, 4 th Edition, 2007.
5.	John P. Hayes, "Computer Architecture and Organization", McGraw Hill.
6.	John P. Shen, "Modern processor design. Fundamentals of super scalar processors", Tata McGraw Hill, 2003.
7.	Kai Hwang, "Advanced Computer Architecture", McGraw Hill International, 2001.
8.	William Stallings, "Computer Organization and Architecture – Designing for Performance", Pearson Education, Seventh Edition, 2006.

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	M19AEE102 - ELECTROMAGNETIC INTERFERENCE	т	Р	ΤU	С
M.E.	AND COMPATIBILITY	3	0	0	3

	Course Objectives		
1.	To study the basics of EMI.		
2.	To learn the coupling mechanism.		
3.	To introduce the problems in EMI.		
4.	To study the different standards.		
5.	To learn the measurement techniques for immunity.		

Introduction to EMI and EMC, Intra and inter system EMI, Elements of Interference, Sources and Victims of EMI, Conducted and Radiated EMI emission and susceptibility, Case Histories, Radiation hazards to humans, Various issues of EMC, EMC Testing categories EMC Engineering Application.

**BASIC THEORY** 

# UNIT - II COUPLING MECHANISM

Electromagnetic field sources and Coupling paths, Coupling via the supply network, Common mode coupling, Differential mode coupling, Impedance coupling, Inductive and Capacitive coupling, Radioactive coupling, Ground loop coupling, Cable related emissions and coupling, Transient sources, Automotive transients.

# UNIT - III

# EMI MITIGATION TECHNIQUES

Working principle of Shielding and Murphy"s Law, LF Magnetic shielding, Apertures and shielding effectiveness, Choice of Materials for H, E, and free space fields, Gasketting and sealing, PCB Level shielding, Principle of Grounding, Isolated grounds, Grounding strategies for Large systems, Grounding for mixed signal systems, Filter types and operation, Surge protection devices, Transient Protection.

# UNIT - IV

# STANDARD AND REGULATION

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Need for Standards, Generic/General Standards for Residential and Industrial environment, Basic Standards, Product Standards, National and International EMI Standardizing Organizations; IEC, ANSI, FCC, AS/NZS, CISPR, BSI, CENELEC, ACEC. Electro Magnetic Emission and susceptibility standards and specifications, MIL461E Standards.

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UNIT - V

#### **EMI TEST METHODS AND INSTRUMENTATION**

Fundamental considerations, EMI Shielding effectiveness tests, Open field test, TEM cell for immunity test, Shielded chamber, Shielded anechoic chamber, EMI test receivers, Spectrum analyzer, EMI test wave simulators, EMI coupling networks, Line impedance stabilization networks, Feed through capacitors, Antennas, Current probes, MIL -STD test methods, Civilian STD test methods.

### **Total Instructional hours : 45**

	Course Outcomes : Students will be able to				
CO1	Outline the basic theory behind EMI.				
CO2	Explain the coupling process.				
CO3	Analyze the mitigation techniques.				
CO4	Outline about different standards.				
CO5	Compare EMI test methods.				
	Reference Books				
1.	Bemhard Keiser, "Principles of Electromagnetic Compatibility", Artech house, Norwood, 3 rd Edition, 1986.				
2.	Clayton Paul, "Introduction to Electromagnetic Compatibility", Wiley Interscience, 2006.				
3.	Daryl Gerke and William Kimmel, "EDN's Designers Guide to Electromagnetic Compatibility", Elsevier Science & Technology Books, 2002.				
4.	Dr Kenneth L Kaiser, "The Electromagnetic Compatibility Handbook", CRC Press, 2005.				
5.	Electromagnetic Compatibility by Norman Violette, Published by Springer, 2013.				
6.	Donald R. J, "Electromagnetic Interference and Compatibility: Electrical noise and EMI specifications", Volume 1 of A Handbook Series on Electromagnetic Interference and Compatibility, White Publisher, Don white consultants Original from the University of Michigan Digitized, 2007.				
7.	Henry W. Ott, "Electromagnetic Compatibility Engineering", John Wiley & Sons Inc, Newyork, 2009.				
8.	V Prasad Kodali, "Engineering Electromagnetic Compatibility", IEEE Press, Newyork, 2001.				
9.	W Scott Bennett, "Control and Measurement of Unintentional Electromagnetic Radiation", John Wiley & Sons Inc., (Wiley Interscience Series) 1997.				

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UNIT - IV

UNIT - V

	M19AEE103 - NEURAL NETWORKS AND APPLICATIONS	т	Ρ	TU	С
WI.E.	(Common to AE & VLSI)	3	0	0	3

	Course Objectives		
1.	To introduce the artificial neural network concepts.		
2.	To study various types of artificial neural network architectures.		
3.	To study advanced artificial neural network concepts.		

UNIT - I	INTRODUCTION TO ARTIFICIAL NEURAL NETWORKS	9
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Neuro-physiology - General Processing Element - ADALINE - LMS learning rule - MADALINE – MR2 training algorithm.

UNIT - II	BPN AND BAM	9
Back Propagation Network - updating of output and hidden layer weights - application of BPN – associati		ociative

Back Propagation Network - updating of output and hidden layer weights -application of BPN – associative memory - Bi-directional Associative Memory - Hopfield memory - traveling sales man problem.

UNIT - III	UNIT - III SIMULATED ANNEALING AND CPN				
Annealing, B	Annealing, Boltzmann machine - learning - application - Counter Propagation network - architecture				

Self organizing map - learning algorithm - feature map classifier - applications - architecture of Adaptive Resonance Theory - pattern matching in ART network.

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**NEOCOGNITRON** 

Architecture of Neocognitron - Data processing and performance of architecture of spacio – temporal networks for speech recognition.

**Total Instructional hours : 45** 

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	Course Outcomes : Students will be able to		
CO1	Explain the concepts of neural networks and different training / learning algorithms.		
CO2	Design BPNN to solve real time problems.		
CO3	Apply the concept of counter propagation network for various applications.		
CO4	Illustrate problem-solving based on pattern matching with specified Self Organizing Map algorithm.		
CO5	Apply spatial - temporal networks for speech recognition		
Reference Books			
1.	J.A. Freeman and B.M. Skapura, "Neural Networks, Algorithms Applications and Programming Techniques", Addison-Wesely, 2003.		

2. Laurene Fausett, "Fundamentals of Neural Networks: Architecture, Algorithms and Applications", Prentice Hall, 2004.

3. Simon Haykin, "Neural Networks & Learning Machines", Pearson Education, Third edition, 2011.

4. Martin T. Hagan, Howard B. Demuth, Mark Beale, "Neural Network Design", Thomson and Learning, Third Reprint, 2008.



# **Semester - II**

M.E.		M19AET201- SOFT COMPUTING AND	T P TU	TU	С	
		OPTIMIZATION TECHNIQUES (Common to AE & VLSI)	3 0		0	3
		Course Objectives				
1.	To u	nderstand various neural networks and learning methods.				
2.	יס סד	verview of Fuzzy logic.				
3.	To st	udy the concept of Neuro – Fuzzy modeling.				
4.	To in	troduce the optimization techniques.				
UNI	UNIT - I NEURAL NETWORKS 9					9
Machine Learning using Neural Network, Learning algorithms, Supervised Learning Neural Networks – Feed Forward Networks, Radial Basis Function, Unsupervised Learning Neural Networks – Self Organizing map , Adaptive Resonance Architectures, Hopfield network.						
UNI	UNIT - II FUZZY LOGIC 9					
Fuzzy Sets – Operations on Fuzzy Sets – Fuzzy Relations – Membership Functions-Fuzzy Rules and Fuzzy Reasoning – Fuzzy Inference Systems – Fuzzy Expert Systems – Fuzzy Decision Making.						
UNIT	Г- III	NEURO - FUZZY MODELING				9

Adaptive Neuro-Fuzzy Inference Systems - Coactive Neuro-Fuzzy Modeling - Classification and Regression Trees – Data Clustering Algorithms – Rule base Structure Identification –Neuro-Fuzzy Control – Case Studies.

UNIT - IV

#### CONVENTIONAL OPTIMIZATION TECHNIQUES

Introduction to optimization techniques, Statement of an optimization problem, classification, Unconstrained optimization-gradient search method-Gradient of a function, steepest gradientconjugate gradient, Newton's Method, Marguardt Method, Constrained optimization - sequential linear programming, Interior penalty function method, external penalty function method.

# UNIT - V

#### **EVOLUTIONARY OPTIMIZATION TECHNIQUES**

Genetic algorithm - working principle, Basic operators and Terminologies, Building block hypothesis, Travelling Salesman Problem, Particle swam optimization, Ant colony optimization.

**Total Instructional hours: 45** 

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Course Outcomes : Students will be able to	
CO1	Outline the basics of neural network and learning methods.
CO2	Outline the basics of fuzzy logic.
CO3	Examine machine learning through Neural Fuzzy concept.
CO4	Explain the conventional optimization techniques.
CO5	Explain the evolutionary optimization techniques.

# **Reference Books** David E. Goldberg, "Genetic Algorithms in Search, Optimization and Machine learning", Addison 1. wesley, 2009. George J. Klir and Bo Yuan, "Fuzzy Sets and Fuzzy Logic-Theory and Applications", Prentice 2. Hall, 1995. James A. Freeman and David M. Skapura, "Neural Networks Algorithms, Applications, and 3. Programming Techniques", Pearson Edn., 2003. Jyh-Shing Roger Jang, Chuen-Tsai Sun, Eiji Mizutani, "Neuro-Fuzzy and Soft Computing", 4. Prentice-Hall of India, 2003. Mitchell Melanie, "An Introduction to Genetic Algorithm", Prentice Hall, 1998. 5. Simon Haykins, "Neural Networks : A Comprehensive Foundation", Prentice Hall International 6. Inc, 1999. Singiresu S. Rao, "Engineering optimization Theory and practice", John Wiley & sons inc, Fourth 7. Edition, 2009. 8. Timothy J. Ross, "Fuzzy Logic with Engineering Applications", McGraw-Hill, 1997. Venkata Rao, Vimal J. Savsani, "Mechanical Design Optimization Using Advanced Optimization 9. Techniques", Springer, 2012.

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### R - 2019 -

M.E.	M19VDE202 - ASIC AND FPGA DESIGN	Т	Р	TU	С
	(Common to VLSI & AE)	3	0	0	3

	Course Objectives
1.	To study the different types of ASIC and PLD.
2.	To gain knowledge about partitioning, floor planning, placement and routing including circuit extraction of ASIC.
3.	To familiarize the different types of programming technologies and testing.
4.	To learn the architecture of different types of FPGA.
5.	To gain knowledge about SoC.

### UNIT - I OVERVIEW OF ASIC AND PLD

Types of ASICs - Design flow – CAD tools used in ASIC Design – Programming Technologies: Antifuse – static RAM – EPROM and EEPROM technology, Programmable Logic Devices: ROMs and EPROMs – PLA –PAL. Gate Arrays – CPLDs and FPGAs.

### UNIT - II

### ASIC PHYSICAL DESIGN

System partition -partitioning - partitioning methods – interconnect delay models and measurement of delay - floor planning - placement – Routing: global routing - detailed routing - special routing - circuit extraction - DRC.

UNIT - III

### LOGIC SYNTHESIS, SIMULATION AND TESTING

Design systems - Logic Synthesis - Half gate ASIC -Schematic entry - Low level design language - PLA tools -EDIF- CFI design representation. Verilog and logic synthesis -VHDL and logic synthesis - types of simulation -boundary scan test - fault simulation - automatic test pattern generation.

### UNIT - IV

### FIELD PROGRAMMABLE GATE ARRAYS

FPGA Design : FPGA Physical Design Tools -Technology mapping - Placement & routing - Register transfer (RT)/Logic Synthesis - Controller/Data path synthesis - Logic minimization.

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UNIT - V

### SOC - DESIGN

System-On-Chip Design - SoC Design Flow, Platform-based and IP based SoC Designs, Basic Concepts of Bus-Based Communication Architectures. High performance algorithms for ASICs/ SoCs as case studies: Canonical Signed Digit Arithmetic, Knowledge Crunching Machine, Distributed Arithmetic, High performance digital filters for sigma-delta ADC.

### Total Instructional hours : 45

	Course Outcomes : Students will be able to
CO1	Outline about various types of ASICs and PLDs.
CO2	Analyze the physical design steps of ASIC.
CO3	Explain the logic synthesis, simulation and testing.
CO4	Analyze the FPGA.
CO5	Explain the design issues of SOC.

	Reference Books
1.	David A. Hodges, "Analysis and Design of Digital Integrated Circuits (3/e)", MGH, 2004.
2.	H.Gerez, "Algorithms for VLSI Design Automation", John Wiley, 1999.
3.	Jan. M. Rabaey et al, "Digital Integrated Circuit Design Perspective (2/e)", PHI, 2003.
4.	M.J.S. Smith, "Application Specific Integrated Circuits", Pearson, 2003.
5.	J. Old Field, R.Dorf, "Field Programmable Gate Arrays", John Wiley& Sons, Newyork.
6.	P.K.Chan & S. Mourad, "Digital Design using Field Programmable Gate Array", Prentice Hall.
7.	Sudeep Pasricha and Nikil Dutt, "On-Chip Communication Architectures System on Chip Interconnect", Elsevier, 2008.
8.	S. Trimberger, Edr, "Field Programmable Gate Array Technology", Kluwer Academic Pub.
9.	S. Brown, R. Francis, J. Rose, Z.Vransic, "Field Programmable Gate Array", Kluwer Pub.
10.	Richard FJinder, "Engineering Digital Design", Academic press.

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	M19VDE303 – HARDWARE-SOFTWARE CO-DESIGN	Т	Ρ	TU	С
IVI.C.	(Common to VLSI & AE)	3	0	0	3

Course Objectives		
1.	To acquire the knowledge about system specification and modelling.	
2.	To learn the formulation of partitioning.	
3.	To learn the co-synthesis.	
4.	To study the different technical aspects about prototyping and emulation.	
5.	To introduce the design specification and verification.	

### UNIT - I SYSTEM SPECIFICATION AND MODELLING

Embedded Systems, Hardware/Software Co-Design, Co-Design for System Specification and Modeling, Co-Design for Heterogeneous Implementation - Single-Processor Architectures with one ASIC and many ASICs, Multi-Processor Architectures, Comparison of Co-Design Approaches, Models of Computation, Requirements for Embedded System Specification.

### UNIT - II

### HARDWARE / SOFTWARE PARTITIONING

The Hardware/Software Partitioning Problem, Hardware-Software Cost Estimation, Generation of the Partitioning Graph, Formulation of the HW/SW Partitioning Problem, Optimization, HW/SW Partitioning based on Heuristic Scheduling, HW/SW Partitioning based on Genetic Algorithms.

UNIT - III

### HARDWARE / SOFTWARE CO-SYNTHESIS

The Co-Synthesis Problem, State-Transition Graph, Refinement and Controller Generation, Co-Synthesis Algorithm for Distributed System- Case Studies with any one application.

### UNIT - IV

### PROTOTYPING AND EMULATION

Introduction, Prototyping and Emulation Techniques, Prototyping and Emulation Environments, Future Developments in Emulation and Prototyping,Target Architecture - Architecture Specialization Techniques ,System Communication Infrastructure, Target Architectures and Application System Classes, Architectures for Control-Dominated Systems, Architectures for Data-Dominated Systems, Mixed Systems and Less Specialized Systems.

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### UNIT - V DESIGN SPECIFICATION AND VERIFICATION

Concurrency, Coordinating Concurrent Computations, Interfacing Components, Verification, Languages for System-Level Specification and Design System-Level Specification ,Design Representation for System Level Synthesis, System Level Specification Languages, Heterogeneous Specification and Multi-Language Co- simulation.

### **Total Instructional hours : 45**

	Course Outcomes : Students will be able to		
CO1	Outline the system specification and modelling.		
CO2	Explain the partitioning and scheduling Algorithm.		
CO3	Explain the co-synthesis algorithm.		
CO4	Compare various architectures od prototyping and emulation.		
CO5	Analyze about the design specification and validate its functionality by simulation.		
Poference Pooks			

	Reference Books
1.	Giovanni De Micheli, Rolf Ernst Morgon, "Reading in Hardware/Software Co-Design", Kaufmann Publishers, 2001.
2.	Jorgen Staunstrup, Wayne Wolf, "Hardware/Software Co-Design : Principles and Practice", Kluwer Academic Pub, 1997.
3.	Ralf Niemann, "Hardware/Software Co-Design for Data Flow Dominated Embedded Systems", Kluwer Academic Pub, 1998.

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M.E.	M19VDT202 - VLSI SIGNAL PROCESSING	Т	Р	TU	С
	(Common to VLSI & AE)	3	0	0	3

	Course Objectives
1.	To learn typical DSP algorithms.
2.	To introduce techniques for altering the existing DSP structures to suit VLSI implementations.
3.	To introduce efficient design of DSP architectures suitable for VLSI.
4.	To study about numerical strength reduction.

### UNIT - I PIPELINING AND PARALLEL PROCESSING OF DIGITAL FILTERS

Introduction to DSP systems – Typical DSP algorithms, Data flow and Dependence graphs – critical path, Loop bound, iteration bound, longest path matrix algorithm, Pipelining and Parallel processing of FIR filters, Pipelining and Parallel processing for low power.

UNIT - II	ALGORITHMIC STRENGTH REDUCTION TECHNIQUE	

Retiming – definitions and properties, Unfolding – an algorithm for unfolding, properties of unfolding, sample period reduction and parallel processing application, Algorithmic strength reduction in filters and transforms – 2-parallel FIR filter, 2-parallel fast FIR filter, DCT architecture, rank-order filters, Odd-Even merge-sort architecture, parallel rank-order filters.

### UNIT - III

### **ALGORITHIMIC STRENGTH REDUCTION - II**

Fast convolution – Cook-Toom algorithm, modified Cook-Toom algorithm, Pipelined and parallel recursive filters – Look - Ahead pipelining in first-order IIR filters, Look-Ahead pipelining with power of - 2 decomposition, Clustered look-ahead pipelining, Parallel processing of IIR filters, combined pipelining and parallel processing of IIR filters.

UNIT - IV

### **BIT - LEVEL ARITHMETIC ARCHITECTURES**

Bit-level arithmetic architectures – parallel multipliers with sign extension, parallel carry- ripple and carry-save multipliers, Design of Lyon's bit-serial multipliers using Horner's rule, bit-serial FIR filter, CSD representation, CSD multiplication using Horner's rule for precision improvement, Distributed Arithmetic fundamentals and FIR filters.

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### NUMERICAL STRENGTH REDUCTION, WAVE AND ASYNCHRONOUS PIPELINING

Numerical strength reduction – subexpression elimination, multiple constant multiplication, iterative matching, synchronous pipelining and clocking styles, clock skew in edge-triggered single phase clocking, two-phase clocking, wave pipelining. Asynchronous pipelining bundled data versus dual rail protocol.

### Total Instructional hours : 45

	Course Outcomes : Students will be able to
CO1	Outline the pipelining and parallel processing of DSP filters.
CO2	Explain the first level strength reduction techniques.
CO3	Explain the first level strength reduction techniques.
CO4	Analyze the various bit level arithmetic architectures.
CO5	Explain the numerical strength reduction and pipelining process of filters.
	Reference Books
1.	Keshab K. Parhi, "VLSI Digital Signal Processing Systems, Design and implementation", Wiley, Interscience, 2007.
2.	U. Meyer – Baese, "Digital Signal Processing with Field Programmable Gate Arrays", Springer, Second Edition, 2004.

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UNIT - V

M.E.	M19AEP201 - ELECTRONICS SYSTEM DESIGN	Т	P	TU	C
	LABORATORY - II	0	4	0	2
	Course Objectives				

1.	To study of 32 bit ARM7 microcontroller RTOS and its application.
2.	To understand testing RTOS environment and system programming.
3.	To learn wireless network design using embedded systems.
4.	To learn System design using ASIC.
5.	To know use of Verilog and VHDL in sequential digital system modeling.

	List of Experiments
Expt. No.	Description of the Experiments
1.	Study of 32 bit ARM7 microcontroller RTOS and its application
2.	Testing RTOS environment and system programming
3.	Designing of wireless network using embedded systems
4.	Implementation of ARM with FPGA
5.	Design and Implementation of ALU in FPGA using VHDL and Verilog
6.	Modelling of Sequential Digital system using Verilog and VHDL
7.	Flash controller programming - data flash with erase, verify and fusing
8.	System design using ASIC
9.	Design, simulation and analysis of signal integrity
	Total Instructional hours : 60

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	Course Outcomes : Students will be able to
CO1	Utilize ARM with FPGA.
CO2	Demonstrate the designing of ALU in FPGA using VHDL and Verilog.
CO3	Outline about the RTOS.
CO4	Examine the flash controller programming.
CO5	Explain design, simulation and analysis of signal integrity.

	List of Equipment Required	
SI. No.	Name of the Equipment	Quantity
1.	ARM 7 Development board with RTOS like Linux or VX works / PIC Microcontroller	10
2.	Vx works or Equivalent RTOS/ 8051 Microcontroller	10
3.	Wireless Modules like Zigbee or equivalent	5
4.	FPGA Board like Spartan 3E or cyclone II ORE	10
5.	XILNX,Quartus-2	10
6.	Flash Programming Kit (Universal Programmes) 8255 PPI	5
7.	Mentor graphics/ Cadence	5
8.	Signal Integrity / TMS320C XXXX DSP based Development trainer	5

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IVI.C.	WIGCEP201 - ARTICLE WRITING AND SEMINAR	0	2	0	1
	Course Objectives				
In this c to unde from a develop	burse, students will develop their scientific and technical reading and rstand and construct research articles. A term paper requires a s variety of sources (i.e., Journals, dictionaries, reference books) a red ideas. The work involves the following steps :	d writing tudent Ind ther	g skills t to obtai n place	hat they in inforr it in log	/ need nation gically
1.	Selecting a subject, narrowing the subject into a topic				
2.	Stating an objective.				
3.	Collecting the relevant bibliography (at least 15 journal papers).				
4.	Preparing a working outline.				
5.	5. Studying the papers and understanding the author's contributions and critically analysing each paper.				
6.	Preparing a working outline.				
7.	Linking the papers and preparing a draft of the paper.				
8.	Preparing conclusions based on the reading of all the papers.				
9.	Writing the Final Paper and giving final Presentation.				

Please keep a file where the work carried out by you is maintained. Activities to be carried out

Activity	Instructions	Submission Week	Evaluation Week
Selection of area of interest and Topic (Stating an Objective)	You are requested to select an area of interest, topic and state an objective	2 nd week	3 % Based on clarity of thought, current relevance and clarity in writing
Collecting Information about your area & topic	<ol> <li>List 1 Special Interest Groups or professional society</li> <li>List 2 journals</li> </ol>	3 rd week	3% (the selected information must be area specific and of international and national standard)

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	<ol> <li>3. List 2 conferences, symposia or workshops</li> <li>4. List 1 thesis title</li> <li>5. List 3 web presences (mailing lists, forums, news sites)</li> <li>6. List 3 authors who publish regularly in your area</li> <li>7. Attach a call for papers (CFP) from your area.</li> </ol>		
Collection of Journal papers in the topic in the context of the objective – collect 20 & then filter	You have to provide a complete list of references you will be using- Based on your objective -Search various digital libraries and Google Scholar When picking papers to read - try to: Pick papers that are related to each other in some ways and/ or that are in the same field so that you can write a meaningful survey out of them, Favour papers from well-known journals and conferences, Favour "first" or "foundational" papers in the field	4 th week	6% ( the list of standard papers and reason for selection)
	(as indicated in other people"s survey paper), Favour more recent papers, Pick a recent survey of the field so you can quickly gain an overview, Find relationships with respect to each other and to your topic area (classification scheme/ categorization) Mark in the hard copy of papers whether complete work or section/sections of the paper are being considered		



Reading and notes for first 5 papers	Reading Paper Process For each paper form a Table answering the following questions: What is the main topic of the article? What was/were the main issue(s) the author said they want to discuss? Why did the author claim it was important? How does the work build on other"s work, in the author"s opinion? What simplifying assumptions does the author claim to be making?	5 th week	8% (the table given should indicate your understanding of the paper and the evaluation is based on your conclusions about each paper)
	What did the author do? How did the author claim they were going to evaluate their work and compare it to others? What did the author claim it was important? How does the work build on other"s work, in the author"s opinion? What simplifying assumptions does the author claim to be making? What did the author do? How did the author claim they were going to evaluate their work and compare it to others? What did the author say were the limitations of their research?	STRECTATION I	



	What did the author say were the important directions for future research? Conclude with limitations / issues not addressed by the paper (from the perspective of your survey)		
Reading and notes for next 5 papers	Repeat Reading Paper Process	6 th week	8% (the table given should indicate your understanding of the paper and the evaluation is based on your conclusions about each paper)
Reading and notes for final 5 papers	Repeat Reading Paper Process	7 th week	8% (the table given should indicate your understanding of the paper and the evaluation is based on your conclusions about each paper)
Draft outline 1 and Linking papers	Prepare a draft Outline, your survey goals, along with a classification / categorization diagram	8 th week	8% ( this component will be evaluated based on the linking and classification among the papers)
Abstract	Prepare a draft abstract and give a presentation	9 th week	6% (Clarity, purpose and conclusion) 6% Presentation & Viva Voce
Introduction Background	Write an introduction and background sections	10 th week	5% ( clarity)

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	Write the sections of		10% (this component
	your paper based on the		will be evaluated based
Sections of the paper	classification / categorization	11 th week	on the linking and
	diagram in keeping with the		classification
	goals of your survey		among the papers)
Veur conclusione	Write your conclusions and	10 th week	5% ( conclusions –
Your conclusions	future work	12" WEEK	clarity and your ideas)
			10% (formatting,
Final Draft	Complete the final draft of your 13 th	13 th week	English, Clarity and
			linking) 4% Plagiarism
			Check Report
			10% (based on
Seminar	A brief 15 slides on your paper	14 th & 15 th week	presentation and
	< YON/		Viva-voce)
	EXON/		Viva-voce)

	Course Outcomes : Students will be able to		
CO1	Survey the relevant information.		
CO2	Outline the importance's.		
CO3	Formulate the concept.		
CO4	Compare the data's with existing.		
CO5	Outline about concluding remarks.		

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# **Professional Elective - II**

M.E.	M19VDT104 - CAD FOR VLSI CIRCUITS	Т	Ρ	TU	С
	(Common to VLSI & AE)	3	0	0	3

Course Objectives		
1.	To introduce the VLSI Design methodologies	
2.	To study the algorithms related to placement and partitioning.	
3.	To study the various routing and floor planning algorithms.	
4.	To learn the synthesis processes understand VLSI design automation tools.	
5.	To study the high level synthesis.	

### UNIT – I INTRODUCTION TO VLSI DESIGN FLOW

Introduction to VLSI Design methodologies, Basics of VLSI design automation tools, Algorithmic Graph Theory and Computational Complexity, Tractable and Intractable problems, General purpose methods for combinatorial optimization.

## UNIT – II LAYOUT, PLACEMENT AND PARTITIONING 9

Layout Compaction, Design rules, Problem formulation, Algorithms for constraint graph compaction, Placement and partitioning, Circuit representation, Placement algorithms, Partitioning.

### UNIT – III

### FLOOR PLANNING AND ROUTING

Floor planning concepts, Shape functions and floor plan sizing, Types of local routing problems, Area routing, Channel routing, Global routing, Algorithms for global routing.

### UNIT – IV

### SIMULATION AND LOGIC SYNTHESIS

Simulation, Gate-level modeling and simulation, Switch-level modeling and simulation, Combinational Logic Synthesis, Binary Decision Diagrams, Two Level Logic Synthesis.

### UNIT – V

### HIGH LEVEL SYNTHESIS

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Hardware models for high level synthesis, internal representation, allocation, assignment and scheduling, scheduling algorithms, Assignment problem, High level transformations.

### **Total Instructional hours: 45**

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	Course Outcomes : Students will be able to
CO1	Outline the flow of VLSI design.
CO2	Explain the algorithms related to placement and partitioning and layout rules.
CO3	Outline floor planning and routing.
CO4	Explain Simulation and Logic Synthesis.
CO5	Examine the hardware models for high level synthesis.

	Reference Books			
1.	N.A. Sherwani, "Algorithms for VLSI Physical Design Automation", Kluwer Academic Publishers, 2002.			
2.	S.H. Gerez, "Algorithms for VLSI Design Automation", John Wiley & Sons, 2002.			
3.	Sadiq M. Sait, Habib Youssef, "VLSI Physical Design automation: Theory and Practice", World Scientific, 1999.			
4.	Steven M.Rubin, "Computer Aids for VLSI Design", Addison Wesley Publishing, 1987.			



M.E.	M19VDE203 - NANO ELECTRONICS	т	Р	τU	С
	(Common to VLSI & AE)	3	0	0	3

Course Objectives		
1.	To understand the semiconductor nano devices.	
2.	To study the materials involved in nano devices.	
3.	To learn the operation of nano thermal sensors.	
4.	To understand various materials used in gas sensors.	
5.	To study the operation of bio sensor.	

### SEMICONDUCTOR NANO DEVICES

Single-Electron Devices; Nano scale MOSFET – Resonant Tunneling Transistor - Single- Electron Transistors; Nanorobotics and Nano manipulation; Mechanical Molecular Nano devices; Nano computers: Optical Fibers for Nano devices; Photochemical Molecular Devices; DNA-Based Nano devices; Gas-Based Nano devices.

UNIT – II

UNIT – I

### ELECTRONIC AND PHOTONIC MOLECULAR MATERIALS

Preparation – Electroluminescent Organic materials - Laser Diodes - Quantum well lasers:- Quantum cascade lasers- Cascade surface-emitting photonic crystal laser- Quantum dot lasers - Quantum wire lasers:- White LEDs - LEDs based on nanowires - LEDs based on nanotubes - LEDs based on nanorods - High Efficiency Materials for OLEDs- High Efficiency Materials for OLEDs - Quantum well infrared photo detectors.

### UNIT – III

### THERMAL SENSORS

Thermal energy sensors -temperature sensors, heat sensors - Electromagnetic sensors - electrical resistance sensors, electrical current sensors, electrical voltage sensors, electrical power sensors, magnetism sensors - Mechanical sensors - pressure sensors, gas and liquid flow sensors, position sensors - Chemical sensors - Optical and radiation sensors.

### UNIT – IV

### **GAS SENSOR MATERIALS**

Criteria for the choice of materials - Experimental aspects – materials, properties, measurement of gas sensing property, sensitivity, Discussion of sensors for various gases, Gas sensors based on semiconductor devices.

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CO2

CO3

CO4

UNIT	- V	BIOSENSORS	9		
Principles - DNA based biosensors – Protein based biosensors – materials for biosensor applications - fabrication of biosensors - future potential.					
Total Instructional hours: 45					
Course Outcomes : Students will be able to					
CO1	Class	ify the types of Nano devices.			

Analyze the materials used in Nano device.

Explain the operation of thermal sensor.

Examine the operation of gas sensor.

CO5	Outline the operation of bio sensor.
	Reference Books
1.	K.E. Drexler, "Nano systems", Wiley, 1992.
2.	M.C. Petty, "Introduction to Molecular Electronics", 1995.
3.	W. Ranier, "Nano Electronics and Information Technology", Wiley, 2003.

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ME	M19AEE201- HIGH PERFORMANCE NETWORKS	т	Р	TU	С
IVI.C.	(Common to AE & VLSI)	3	0	0	3

Course Objectives		
1.	To introduce various systems related to networks.	
2.	To study the applications of multimedia networks.	
3.	To learn the concept of advanced networks.	
4.	To study the various traffic modeling.	
5.	To learn about network security in many layers and network management.	

UNIT – I	INTRODUCTION	9
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Review of OSI, TCP/IP; Multiplexing, Modes of Communication, Switching, Routing. SONET – DWDM – DSL – ISDN – BISDN, ATM.

UNIT – II	MULTIMEDIA NETWORKING APPLICATIONS	9
UNIT – II	MULTIMEDIA NETWORKING APPLICATIONS	9

Streaming stored Audio and Video – Best effort service – protocols for real time interactive applications – Beyond best effort – scheduling and policing mechanism – integrated services – RSVP- differentiated services.

UNIT – III
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### ADVANCED NETWORKS CONCEPTS

VPN-Remote-Access VPN, site-to-site VPN, Tunneling to PPP, Security in VPN.MPLS - operation, Routing, Tunneling and use of FEC, Traffic Engineering, MPLS based VPN, overlay networks - P2P connections.

UNII - IV	UNIT	– IV
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### TRAFFIC MODELLING

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Little's theorem, Need for modeling, Poisson modeling and its failure, Non- poisson models, Network performance evaluation.

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### UNIT – V

### NETWORK SECURITY AND MANAGEMENT

Principles of cryptography – Authentication – integrity – key distribution and certification – Access control and: fire walls – attacks and counter measures – security in many layers. Infrastructure for network management – The internet standard management framework – SMI, MIB, SNMP, Security and administration – ASN.1.

### Total Instructional hours: 45

	Course Outcomes : Students will be able to	
CO1	Outline the basic high performance network systems.	
CO2	Explain the applications of multimedia networks.	
CO3	Analyse the concepts of advanced networks.	
CO4	Outline the traffic modelling.	
CO5	Analyse the network security methods	

	Reference Books
1.	Aunurag Kumar, D. M Anjunath, Joy Kuri, "Communication Networking", Morgan Kaufmann Publishers, 1 st Edition, 2004.
2.	Fred Halsall and Lingana Gouda Kulkarni, "Computer Networking and the Internet", Pearson Education, Fifth edition, 2006.
3.	Hersent Gurle & Petit, "IP Telephony, packet Pored Multimedia communication Systems", Pearson Education, 2003.
4.	J.F. Kurose & K.W. Ross, "Computer Networking - A top down approach featuring the internet", Pearson, 2 nd Edition, 2003.
5.	Larry I.Peterson & Bruce S.David, "Computer Networks: A System Approach", 1996.
6.	LEOM-GarCIA, WIDJAJA, "Communication networks", Seventh reprint, TMH, 2002.
7.	Nader F.Mir, "Computer and Communication Networks", First edition, 2010.
8.	Walrand .J. Varatya, "High performance communication network", Morgan Kauffman – Harcourt Asia Pvt. Ltd., 2 nd Edition, 2000.

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	M19AEE202 - WIRELESS ADHOC AND	Т	Ρ	TU	С
M.E.	SENSOR NETWORKS			•	•
	(Common to AE & VLSI)	3	0	0	3

# Course Objectives1.To understand the basics of Ad-hoc, Sensor Networks and various fundamental and emerging<br/>protocols of all layers.2.To study about the routing architecture of sensor networks.3.To understand the nature and applications of Ad-hoc and sensor networks.4.To understand various security practices and protocols of Ad-hoc and Sensor networks.

### UNIT – I

### MAC & TCP IN AD HOC NETWORKS

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Fundamentals of WLANs – IEEE 802.11 Architecture - Self configuration and Auto configuration-Issues in Ad-Hoc Wireless Networks – MAC Protocols for Ad-Hoc Wireless Networks – Contention Based Protocols - TCP over Ad-Hoc networks-TCP protocol overview - TCP and MANETs – Solutions for TCP over Ad-Hoc Networks.

### UNIT – II

### **ROUTING IN AD HOC NETWORKS**

Routing in Ad-Hoc Networks- Introduction-Topology based versus Position based Approaches-Proactive, Reactive, Hybrid Routing Approach-Principles and issues – Location services - DREAM – Quorums based location service – Grid – Forwarding strategies – Greedy packet forwarding – Restricted directional flooding- Hierarchical Routing- Issues and Challenges in providing QoS.

UNIT – III

### MAC, ROUTING & QOS IN WIRELESS SENSOR NETWORKS

Introduction – Architecture - Single node architecture – Sensor network design considerations – Energy Efficient Design principles for WSNs – Protocols for WSN – Physical Layer : Transceiver Design considerations – MAC Layer Protocols – IEEE 802.15.4 Zigbee – Link Layer and Error Control issues - Routing Protocols – Mobile Nodes and Mobile Robots - Data Centric & Contention Based Networking – Transport Protocols & QOS – Congestion Control issues – Application Layer support.

### UNIT – IV

### SENSOR MANAGEMENT

Sensor Management - Topology Control Protocols and Sensing Mode Selection Protocols - Time synchronization - Localization and positioning – Operating systems and Sensor Network programming – Sensor Network Simulators.

### UNIT – V

### SECURITY IN AD HOC AND SENSOR NETWORKS

Security in Ad-Hoc and Sensor networks – Key Distribution and Management – Software based Antitamper techniques – water marking techniques – Defense against routing attacks - Secure Adhoc routing protocols – Broadcast authentication WSN protocols – TESLA – Biba – Sensor Network Security Protocols – SPINS.

### **Total Instructional hours: 45**

	Course Outcomes : Students will be able to	
CO1	Explain the protocols developed for ad hoc and sensor networks.	
CO2	Analyse different routing approaches.	
CO3	Outline different architecture in ad hoc and sensor networks.	
CO4	Build a Sensor network environment for different type of applications.	
CO5	Analyse about the security in sensor networks.	

	Reference Books
1.	Adrian Perrig, J. D. Tygar, "Secure Broadcast Communication: In Wired and Wireless Networks", Springer, 2006.
2.	Carlos De Morais Cordeiro, Dharma Prakash Agrawal "Ad Hoc and Sensor Networks: Theory and Applications", (2nd Edition), World Scientific Publishing, 2011.
3.	C.Siva Ram Murthy and B.S.Manoj, "Ad Hoc Wireless Networks – Architectures and Protocols", Pearson Education, 2004.
4.	C.K.Toh, "Ad Hoc Mobile Wireless Networks", Pearson Education, 2002.
5.	Erdal Çayırcı, Chunming Rong, "Security in Wireless Ad Hoc and Sensor Networks", John Wiley and Sons, 2009.
6.	Holger Karl, Andreas willig, "Protocols and Architectures for Wireless Sensor Networks", John Wiley & Sons Inc., 2005.
7.	Subir Kumar Sarkar, T G Basavaraju, C Puttamadappa, "Ad Hoc Mobile Wireless Networks", Auerbach Publications, 2008.
8.	Waltenegus Dargie, Christian Poellabauer, "Fundamentals of Wireless Sensor Networks Theory and Practice", John Wiley and Sons, 2010.

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# **Professional Elective - III**

		т	Ρ	τυ	С
IVI.C.	WIJAEE203 - RF STSTEW DESIGN	3	0	0	3

Course Objectives	
1.	To study the physics and specifications of CMOS.
2.	To learn about impedance matching.
3.	To introduce power amplifiers for RF system.
4.	To study the concept of oscillators and mixers.
5.	To learn the concept of PLL.

### UNIT – I CMOS PHYSICS, TRANSCEIVER SPECIFICATIONS AND ARCHITECTURES

Introduction to MOSFET Physics, Noise: Thermal, shot, flicker, popcorn noise, Two port Noise theory, Noise Figure, THD, IP2, IP3, Sensitivity, SFDR, Phase noise - Specification distribution over a communication link, Homodyne Receiver, Heterodyne Receiver, Image reject, Low IF Receiver Architectures Direct up conversion Transmitter, Two step up conversion Transmitter.

UNIT – II	IMPEDANCE MATCHING AND AMPLIFIERS
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S-parameters with Smith chart, Passive IC components, Impedance matching networks, Common Gate, Common Source Amplifiers, OC Time constants in bandwidth estimation and enhancement, High frequency amplifier design, Power match and Noise match, Single ended and Differential LNAs, Terminated with Resistors and Source Degeneration LNAs.

### UNIT – III

### FEEDBACK SYSTEMS AND POWER AMPLIFIERS

Stability of feedback systems: Gain and phase margin, Root-locus techniques, Time and Frequency domain considerations, Compensation, General model – Class A, AB, B, C, D, E and F amplifiers, Power amplifier Linearization Techniques, Efficiency boosting techniques, ACPR metric, Design considerations.

### UNIT – IV

### MIXERS AND OSCILLATORS

Mixer characteristics, Non-linear based mixers, Quadratic mixers, Multiplier based mixers, Single balanced and double balanced mixers, subsampling mixers, Oscillators describing Functions, Colpitts oscillators Resonators, Tuned Oscillators, Negative resistance oscillators, Phase noise.

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UNIT – V

### PLL AND FREQUENCY SYNTHESIZERS

Linearized Model, Noise properties, Phase detectors, Loop filters and Charge pumps, Integer-N frequency synthesizers, Direct Digital Frequency synthesizers.

### Total Instructional hours: 45

Course Outcomes : Students will be able to	
CO1	Outline the physical nature of CMOS in RF system design.
CO2	Analyze the impedance matching processing.
CO3	Explain the concept of power amplifiers in RF system design.
CO4	Build the oscillator for RF system.
CO5	Analyze the PLL for RF system.

	Reference Books
1.	B. Razavi, "Design of Analog CMOS Integrated Circuits", McGraw Hill, 2001.
2.	B. Razavi, "RF Microelectronics", Pearson Education, 1997.
3.	Jan Crols, Michiel Steyaert, "CMOS Wireless Transceiver Design", Kluwer Academic Publishers, 1997.
4.	Recorded lectures and notes available at http://www.ee.iitm.ac.in/~ani/ee6240/
5.	T.Lee, "Design of CMOS RF Integrated Circuits", Cambridge, 2004.



	M19AEE204 - SPEECH AND AUDIO SIGNAL	Т	Ρ	TU	С
M.E.	PROCESSING	3	0	0	3

Course Objectives	
1.	To study basic concepts of processing speech and audio signals.
2.	To study and analyse various M-band filter-banks for audio coding.
3.	To understand audio coding based on transform coders.
4.	To study time and frequency domain speech processing methods.
5.	To learn the predictive analysis of speech.

### UNIT – I MECHANICS OF SPEECH AND AUDIO

Introduction - Review of Signal Processing Theory-Speech production mechanism – Nature of Speech signal – Discrete time modelling of Speech production – Classification of Speech sounds – Phones – Phonemes – Phonetic and Phonemic alphabets – Articulatory features. Absolute Threshold of Hearing - Critical Bands- Simultaneous Masking, Masking- Asymmetry, and the Spread of Masking- Non-simultaneous Masking - Perceptual Entropy - Basic measuring philosophy -Subjective versus objective perceptual testing - The perceptual audio quality measure (PAQM) - Cognitive effects in judging audio quality.

### UNIT – II TIME-FREQUENCY ANALYSIS: FILTER BANKS AND TRANSFORMS

Introduction - Analysis-Synthesis Framework for M-band Filter Banks- Filter Banks for Audio Coding: Design Considerations - Quadrature Mirror and Conjugate Quadrature Filters - Tree-Structured QMF and CQF M-band Banks - Cosine Modulated "Pseudo QMF" M-band Banks -Cosine Modulated Perfect Reconstruction (PR) M-band Banks and the Modified Discrete Cosine Transform (MDCT) - Discrete Fourier and Discrete Cosine Transform - Pre- echo Distortion- Pre-echo Control Strategies.

### UNIT – III

### AUDIO CODING AND TRANSFORM CODERS

Lossless Audio Coding – Lossy Audio Coding - ISO-MPEG-1A, 2A, 2A-Advaned, 4A Audio Coding -Optimum Coding in the Frequency Domain - Perceptual Transform Coder – Brandenburg - Johnston Hybrid Coder - CNET Coders - Adaptive Spectral Entropy Coding -Differential Perceptual Audio Coder - DFT Noise Substitution -DCT with Vector Quantization -MDCT with Vector Quantization

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### UNIT – IV TIME AND FREQUENCY DOMAIN METHODS FOR SPEECH PROCESSING

Time domain parameters of Speech signal – Methods for extracting the parameters Energy, Average Magnitude – Zero crossing Rate – Silence Discrimination using ZCR and energy Short Time Fourier analysis – Formant extraction – Pitch Extraction using time and frequency domain methods Homomorphic Speech Analysis: Cepstral analysis of Speech – Formant and Pitch Estimation – Homomorphic Vocoders.

### UNIT - V

### PREDICTIVE ANALYSIS OF SPEECH

Formulation of Linear Prediction problem in Time Domain – Basic Principle – Auto correlation method – Covariance method – Solution of LPC equations – Cholesky method – Durbin's Recursive algorithm – lattice formation and solutions – Comparison of different methods – Application of LPC parameters – Pitch detection using LPC parameters – Formant analysis – VELP – CELP.

### **Total Instructional hours: 45**

	Course Outcomes : Students will be able to	
CO1	Outline the speech processing concepts.	
CO2	Explain the filter bank concept.	
CO3	Compare various coding and coders. COIMBATORE	
CO4	Examine time and frequency domain methods for speech processing.	
CO5	Explain the predictive analysis of speech.	

	Reference Books
1.	B.Gold and N.Morgan, "Speech and Audio Signal Processing", Wiley and Sons, 2000.
2.	L.R.Rabiner and R.W.Schaffer, "Digital Processing of Speech Signals", Prentice Hall, 1978.
3.	Mark Kahrs, Karlheinz Brandenburg, Kluwer, "Applications of Digital Signal Processing to Audio And Acoustics", Academic Publishers.
4.	Udo Zölzer, "Digital Audio Signal Processing", Second Edition, John Wiley & Sons Ltd.

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M.E.	M19VDE201 - DEVICE MODELLING	Т	Ρ	TU	С
	(Common to VLSI & AE)	0	2	0	1

	Course Objectives		
1.	To study the MOS capacitors and to model MOS Transistors.		
2.	To learn about the MOSFET characteristics.		
3.	To understand the various CMOS design parameters and their impact on performance of the device.		
4.	To study the device level characteristics of BJT transistors.		

Surface Potential: Accumulation, Depletion, and Inversion, Electrostatic Potential and Charge Distribution in Silicon, Capacitances in an MOS Structure, Polysilicon-Gate Work Function and Depletion Effects,

MOS under Non-equilibrium and Gated Diodes, Charge in Silicon Dioxide and at the Silicon–Oxide Interface, Effect of Interface Traps and Oxide Charge on Device Characteristics, High-Field Effects, Impact Ionization and Avalanche Breakdown, Band-to-Band Tunneling, Tunneling into and through Silicon Dioxide, Injection of Hot Carriers from Silicon into Silicon Dioxide, High-Field Effects in Gated Diodes, Dielectric Breakdown.

MOS CAPACITORS

UNIT – II	
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UNIT – I

### MOSFET DEVICES

Long-Channel MOSFETs, Drain-Current Model, MOSFET I–V Characteristics, SubthresholdCharacteristics, Substrate Bias and Temperature Dependence of Threshold Voltage, MOSFET Channel Mobility, MOSFET Capacitances and Inversion-Layer Capacitance Effect, Short-Channel MOSFETs, Short-Channel Effect, Velocity Saturation and High-Field Transport Channel Length Modulation, Source–Drain Series Resistance, MOSFET Degradation and Breakdown at High Fields.

UNIT	– III
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### CMOS DEVICE DESIGN

MOSFET Scaling, Constant-Field Scaling, Generalized Scaling, Non- scaling Effects, Threshold Voltage, Threshold-Voltage Requirement, Channel Profile Design, Non-uniform Doping, Quantum Effect on Threshold Voltage, Discrete Dopant Effects on Threshold Voltage, MOSFET Channel Length, Various Definitions of Channel Length, Extraction of the Effective Channel Length, Physical Meaning of Effective Channel Length, Extraction of Channel Length by C–V Measurements.

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### UNIT – IV

### **CMOS PERFORMANCE FACTORS**

Basic CMOS Circuit Elements, CMOS Inverters, CMOS NAND and NOR Gates, Inverter and NAND Layouts, Parasitic Elements, Source–Drain Resistance, Parasitic Capacitances, Gate Resistance, Interconnect R and C, Sensitivity of CMOS Delay to Device Parameters, Propagation Delay and Delay Equation, Delay Sensitivity to Channel Width, Length, and Gate Oxide Thickness, Sensitivity of Delay to Power-Supply Voltage and Threshold Voltage, Sensitivity of Delay to Parasitic Resistance and Capacitance, Delay of Two-Way NAND and Body Effect, Performance Factors of Advanced CMOS Devices, MOSFETs in RF Circuits, Effect of Transport Parameters on CMOS Performance, Low-Temperature CMOS.

UNIT – V

### **BIPOLAR DEVICES**

N–P–N Transistors, Basic Operation of a Bipolar Transistor, Modifying the Simple Diode Theory for Describing Bipolar Transistors, Ideal Current–Voltage Characteristics, Collector Current, Base Current, Current Gains, Ideal IC–VCE Characteristics, Characteristics of a Typical n–p–n Transistor, Effect of Emitter and Base Series Resistances, Effect of Base– Collector Voltage on Collector Current, Collector Current Falloff at High Currents, Non- ideal Base Current at Low Currents, Bipolar Device Models for Circuit and Time-Dependent Analyses Basic dc Model, Basic ac Model, Small-Signal Equivalent-Circuit Model, Emitter Diffusion Capacitance, Charge-Control Analysis, Breakdown Voltages, Common-Base Current Gain in the Presence of Base–Collector Junction Avalanche, Saturation Currents in a Transistor, Relation Between BVCEO and BVCBO.

### **Total Instructional hours: 45**

	Course Outcomes : Students will be able to	
CO1	Outline the concept of MOS capacitors.	
CO2	Explain the operation of MOSFET with its characteristics.	
CO3	Design and model MOSFET device to desired specifications.	
CO4	Analyze the performance metrics of CMOS.	
CO5	Design and model BJT device to desired specifications.	

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	Reference Books
1.	Behzad Razavi, "Fundamentals of Microelectronics", Wiley Student Edition, 2 nd Edition.
2.	J P Collinge, C.A. Collinge, "Physics of Semiconductor devices", Springer, 2002.
3.	Yuan Taur and Tak H. Ning, "Fundamentals of Modern VLSI Devices", Cambridge University Press, Second Edition.



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	M19AEE205 – ROBOTICS	т	Ρ	τU	С
IVI.E.	(Common to AE and VLSI)	3	0	0	3

	Course Objectives		
1.	To understand robot locomotion and mobile robot kinematics.		
2.	To understand perception in robotics.		
3.	To study mobile robot localization.		
4.	To learn the mobile robot mapping.		
5.	To study robot planning and navigation.		

### UNIT – I LOCOMOTION AND KINEMATICS

Introduction to Robotics – key issues in robot locomotion – legged robots – wheeled mobile robots – aerial mobile robots – introduction to kinematics – kinematics models and constraints – robot maneuverability.

### UNIT – II

### **ROBOT PERCEPTION**

Sensors for mobile robots – vision for robotics – cameras – image formation – structure from stereo – structure from motion – optical flow – color tracking – place recognition – range data.

### UNIT – III

### MOBILE ROBOT LOCALIZATION

Introduction to localization – challenges in localization – localization and navigation – belief representation – map representation – probabilistic map-based localization – Markov localization – EKF localization – UKF localization – Grid localization – Monte Carlo localization – localization in dynamic environments.

### UNIT – IV

### **MOBILE ROBOT MAPPING**

Autonomous map building – occupancy grip mapping – MAP occupancy mapping – SLAM –extended Kalman Filter SLAM – graph-based SLAM – particle filter SLAM – sparse extended information filter – fastSLAM algorithm.

### UNIT – V

### PLANNING AND NAVIGATION

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Introduction to planning and navigation – planning and reacting – path planning – obstacle avoidance techniques – navigation architectures – basic exploration algorithms.

**Total Instructional hours: 45** 

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Course Outcomes : Students will be able to	
CO1	Explain robot locomotion, kinematics models and constraints.
CO2	Analyze the vision algorithms for robotics.
CO3	Test robot localization techniques.
CO4	Test robot mapping techniques.
CO5	Analyze the planning and exploration algorithms.

Reference Books		
1.	Gregory DudekandMichael Jenkin, "Computational Principles of Mobile Robotics", Second Edition, Cambridge University Press, 2010.	
2.	Howie Choset et al., "Principles of Robot Motion: Theory, Algorithms, and Implementations", A Bradford Book, 2005.	
3.	Maja J. Mataric, "The Robotics Primer", MIT Press, 2007.	
4.	Roland Seigwart, Illah Reza Nourbakhsh, and Davide Scaramuzza, "Introduction to autonomous mobile robots", Second Edition, MIT Press, 2011.	
5.	Sebastian Thrun, Wolfram Burgard, and Dieter Fox, "Probabilistic Robotics", MIT Press, 2005.	

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# Semester - III

#### R - 2019 —

UNIT – I

UNIT – II

UNIT – IV

M.E.	M19AET301 - ADVANCED MICROPROCESSORS AND	т	Р	τu	С
	MICROCONTROLLERS ARCHITECTURE	3	0	0	3
	(Common to AE & VLSI)				

Course Objectives		
1.	To study 80486 and Pentium processor.	
2.	To understand CISC and RISC Architectures.	
3.	To learn ARM processor.	
4.	To learn ARM instruction set.	
5.	To study about microcontroller.	

UNIT – I	80486 AND PENTIUM PROCESSOR	9		
80486 PROCESSOR : Basic programming model – Memory organization – Data types – Instruction set -				
Addressing m	node – Address translation – Interrupts – PENTIUM PROCESSOR Introduction to P	entium		
processor architecture – Special Pentium Registers – Pentium Memory Management – Introduction to				
Pentium pro p	processor – Pentium Pro Special Features.			

Introduction to RISC architectures: RISC Versus CISC - RISC Case studies: MIPS R4000-SPARC -Intel i860 - IBM RS/6000.

**CISC AND RISC ARCHITECTURE** 

UNIT – III ARM PROCESSOR	9			
ARM Programmer's Model - Registers - Processor Modes - State of the processor - Condition	ו Flags			
- ARM Pipelines - Exception Vector Table - ARM Processor Families - Typical 3 stage pipeline	d ARM			
organization–Introduction to ARM Memory Management Unit, Case Study.				

UNIT – IV	ARM ADDRESSING MODES AND INSTRUCTION SET	9
ARM Address	sing Modes – ARM Instruction Set Overview – Thumb Instruction Set Overview – LP	C210X
ARM Process	sor Features, Case Study.	

UNIT – V PIC MICROCONTROLLER AND MOTOROLA 68HC11 MICROCONTROLLER 9 Instruction set, addressing modes - operating modes- Interrupt system- RTC-Serial Communication

Interface – A/D Converter PWM and UART. MOTOROLA: CPU Architecture – Instruction set – interrupts-Timers- I2C Interfacing –UART- A/D Converter – PWM, Case Study.

**Total Instructional hours: 45** 

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	Course Outcomes : Students will be able to
CO1	Outline the basics of 80486 processor.
CO2	Explain the functionalities of CISC and RISC architecture.
CO3	Analyze the functionalities of ARM processor.
CO4	Outline ARM instruction set.
CO5	Explain PIC microcontroller and Motorola 68HC11 microcontroller.

	Reference Books			
1.	Andrew Sloss, "ARM System Developers Guide", Morgan Kaufmann Publishers, 2005. approach", Morgan Kaufmann / Elsevier, 1997.			
2.	Barry B Brey, "The Intel Microprocessor, Pentium and Pentium Pro Processor, Architecture Programming and Interfacing", Prentice Hall of India, 2002.			
3.	Daniel Tabak, "Advanced Microprocessors", McGraw Hill Inc., 1995.			
4.	David E Simon "An Embedded Software Primer", Pearson Education, 2007.			
5.	Gene .H.Miller, "Micro Computer Engineering", Pearson Education, 2003.			
6.	Intel, "Microprocessors", Vol-I & Vol-II, Intel Corporation, USA, 1992.			
7.	John B. Peatman, "Design with PIC Microcontroller", Prentice hall, 1997.			
8.	Mohammed Rafiquzzaman, "Microprocessors and Microcomputer Based System Design", Universal Book Stall, New Delhi, 1990.			
9.	Steve Furber, "ARM System-on-Chip Architecture", Pearson Education, 2005.			
10.	"ARM7 TDMI Technical Reference Manual", ARM Ltd., UK, 2004.			

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# **Professional Elective - IV**

M.E.	M19AEE301 - DSP PROCESSOR ARCHITECTURE	т	Ρ	ΤU	С
	AND PROGRAMMING	3	0	0	3

Course Objectives		
1.	To study Digital Signal Processor basics.	
2.	To learn TMS320C5X processor.	
3.	To learn TMS320C6X processor.	
4.	To study about ADSP Processors.	
5.	To study about Advanced Processors.	

### UNIT – I FUNDAMENTALS OF PROGRAMMABLE DSPs

Multiplier and Multiplier accumulator – Modified Bus Structures and Memory access in PDSPs – Multiple access memory – Multi-port memory – VLIW architecture- Pipelining – Special Addressing modes in P-DSPs – On chip Peripherals.

UNIT – II	TMS320C5X PROCESSOR	9
	COIMBATORE	_

Architecture – Assembly language syntax - Addressing modes – Assembly language Instructions -Pipeline structure, Operation – Block Diagram of DSP starter kit – Application Programs for processing real time signals.

UNIT – III	TMS320C6X PROCESSOR	9
Architecture	of the C6x Processor - Instruction Set - DSP Development System: Introduction	– DSP
Starter Kit Support Tools- Code Composer Studio - Support Files - Programming Examples to Test the		
DSK Tools – Application Programs for processing real time signals.		

UNIT – IV	ADSP PROCESSORS	9
Architecture	of ADSP-21XX and ADSP-210XX series of DSP processors- Addressing mod	es and
assembly lan	guage instructions – Application programs –Filter design, FFT calculation.	

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UNIT – V	ADVANCED PROCESSORS

Architecture of TMS320C54X: Pipe line operation, Code Composer studio – Architecture of TMS320C6X - Architecture of Motorola DSP563XX – Comparison of the features of DSP family processors, Case Study.

# **Total Instructional hours: 45**

	Course Outcomes : Students will be able to	
CO1	Outline the basics of Digital Signal Processor.	
CO2	Examine the Architecture of TMS320C5X Processor.	
CO3	Examine the Architecture of TMS320C6X Processor.	
CO4	Outline about the ADSP Processors.	
CO5	Explain about the Advanced Processors.	

	Reference Books
1.	Avtar Singh and S. Srinivasan, "Digital Signal Processing – Implementations using DSP Microprocessors with Examples from TMS320C54xx", Cengage Learning India Private Limited, Delhi, 2012.
2.	B. Venkataramani and M. Bhaskar, "Digital Signal Processors – Architecture, Programming and Applications", Tata McGraw – Hill Publishing Company Limited, New Delhi, 2003.
3.	Rulph Chassaing, "Digital Signal Processing and Applications with the C6713 and C6416 DSK", A JOHN WILEY & SONS, INC., PUBLICATION, 2005.
4.	"User guides Texas Instrumentation", Analog Devices, Motorola.

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M.E.	M19AEE302 - WAVELETS AND MULTIRESOLUTION	т	Ρ	TU	С
	PROCESSING	3	0	0	3

Course Objectives	
1.	To study about the basics of wavelet transform.
2.	To learn Multi Resolution Analysis.
3.	To learn continuous wavelet transforms.
4.	To study about discrete wavelet transform.
5.	To study about applications of wavelet transform.

### INTRODUCTION

Vector Spaces - properties - dot product - basis - dimension, orthogonality and orthonormality relationship between vectors and signals - Signal spaces - concept of Convergence - Hilbert spaces for energy signals - Generalised Fourier Expansion.

# UNIT – II

UNIT – I

#### **MULTI RESOLUTION ANALYSIS**

Definition of Multi Resolution Analysis (MRA) - Haar basis - Construction of general orthonormal MRA-Wavelet basis for MRA - Continuous time MRA interpretation for the DTWT - Discrete time MRA- Basis functions for the DTWT – PROME filter banks.

# UNIT – III

#### **CONTINUOUS WAVELET TRANSFORM**

Wavelet Transform - definition and properties - concept of scale and its relation with frequency -Continuous Wavelet Transform (CWT) - Scaling function and wavelet functions (Daubechies, Coiflet, Mexican Hat, Sinc, Gaussian, Bi-Orthogonal) - Tiling of time -scale plane for CWT.

# UNIT – IV

#### DISCRETE WAVELET TRANSFORM

Filter Bank and sub band coding principles - Wavelet Filters - Inverse DWT computation by Filter banks -Basic Properties of Filter coefficients - Choice of wavelet function coefficients - Mallat's algorithm for DWT - Lifting Scheme: Wavelet Transform using Polyphase matrix Factorization - Geometrical foundations of lifting scheme - Lifting scheme in Z –domain.

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UNIT – V

# APPLICATIONS

Image Compression using DWT – Sequential / Progressive - JPEG 2000 standard - Image denoising -Edge detection and object Isolation and Object Detection - Image Fusion - Wavelet Packets- Multiwavelets - Non linear wavelets – Ridgelets – Curvelets – Contourlets.

# **Total Instructional hours: 45**

	Course Outcomes : Students will be able to		
CO1	Illustrate the fundamentals of vectors, signals, Hilbert and Fourier signal spaces.		
CO2	Analyze signals using Multi Resolution Analysis.		
CO3	Assess the different family of wavelets for real-time applications.		
CO4	Apply wavelet transform for image processing.		
CO5	Explain the principle of non-linear wavelets.		

Reference Books		
1.	Sidney Burvus C, Ramesh A.Gopinath haito, "Introduction to wavelets and wavelet Transform", Prentice Hall International, 1995.	
2.	Gilbert Strang, "Linear Algebra and its Applications", 3 rd Edition.	
3.	Goswami J.C, Chan A.K, "Fundamentels of wavelets", John wiley and sons, 1999.	
4.	Strang G, Nguyen T, "Wavelets and Filter Banks", Wellesley Cambridge Press, 1996.	
5.	Vetterli M, Kovacevic J, "Wavelets and Sub-band Coding", Prentice Hall, 1995.	
6.	Mallat S, "Wavelet Signal Processing", Academic Press, 1996.	

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мг	M19VDE204 - SYSTEM ON CHIP DESIGN	т	Р	τU	С
IVI	(Common to VLSI & AE)	3	0	0	3

Course Objectives	
1.	To introduce SoC concepts.
2.	To study the system level modelling.
3.	To learn the hardware/software co-design principles.
4.	To familiar with system synthesis.
5.	To learn the hardware/software co-verification principles.

#### INTRODUCTION

Introduction to SoC Design, system level design, methodologies and tools, system hardware: IO, communication, processing units, memories; operating systems: prediction of execution, real time scheduling, embedded OS, middle ware; Platform based SoC design, multiprocessor SoC and Network on Chip, Low power SoC Design.

# UNIT – II

UNIT – I

#### SYSTEM LEVEL MODELLING

System C : overview, Data types, modules, notion of time, dynamic process, basic channels, structure communication, ports and interfaces, Design with examples.

#### UNIT – III

#### HARDWARE SOFTWARE CO-DESIGN

Analysis, partitioning, high level optimisations, real-time scheduling, hardware acceleration, voltage scaling and power management; Virtual platform models, co-simulation and FPGAs for prototyping of HW/SW systems.

# UNIT – IV

#### **SYNTHESIS**

System synthesis: Transaction Level Modelling (TLM) based design, automaticTLM generation and mapping, platform synthesis; software synthesis: code generation, multi task synthesis, internal and external communication; Hardware synthesis: RTL architecture, Input models, estimation and optimisation, resource sharing and pipelining and scheduling.

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#### UNIT – V

#### SOC VERIFICATION AND TESTING

SoC and IP integration, Verification: Verification technology options, verification methodology, overview: system level verification, physical verification, hardware/software co-verification; Test requirements and methodologies, SoC design for testability - System modelling, test power dissipation, test access mechanism, Case Study.

### Total Instructional hours: 45

	Course Outcomes : Students will be able to	
CO1	Outline the basics of SoC design.	
CO2	Explain the modelling process.	
CO3	Analyse and design the software hardware models.	
CO4	Explain the synthesis process.	
CO5	Design the test mechanism for SoC test and verification.	

	Reference Books
1.	D. Black, J. Donovan, "SystemC: From the Ground Up", Springer, 2004.
2.	D. Gajski, S. Abdi, A. Gerstlauer, G. Schirner, "Embedded System Design: Modeling, Synthesis, Verification", Springer, 2009.
3.	C.Siva Ram Murthy and B.S.Manoj, "Ad Hoc Wireless Networks – Architectures and Protocols", Pearson Education, 2004.
4.	Erik Larson, "Introduction to advanced system-on-chip test design and optimization", Springer, 2005.
5.	Grotker, T., Liao, S., Martin, G. & Swan, S., "System design with System C", Springer, 2002.
6.	Holger Karl, Andreaswillig, "Protocols and Architectures for Wireless Sensor Networks", John Wiley & Sons Inc., 2005.

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7.	Ghenassia, F., "Transaction-level modeling with System C: TLM concepts and applications for embedded systems", Springer, 2010.
8.	Hoi-junyoo, Kangmin Lee, Jun Kyoungkim, "Low power NoC for high performance SoC design", CRC press, 2008.
9.	M. L. Bushnell and V.D. Agrawal, "Essentials of Electronic Testing for Digital Memory and Mixed Signal VLSI Circuits", Springer, 2005.
10.	M. Abramovici, M. Breuer, and A. Friedman, "Digital System Testing and Testable Design", IEEE Press, 1994.
11.	P. Marwedel, "Embedded System Design", Springer, 2003.
12.	Prakash Rashinkar, Peter Paterson and Leena Singh, "System-on-a chip verification: Methodology and techniques", kluwer Academic Publishers, 2002.
13.	T. Noergaard, "Embedded Systems Architecture: A Comprehensive Guide for Engineers and Programmers", Newness.
14.	Vijay K. Madisetti Chonlameth Arpikanondt, "A Platform-Centric Approach to System- on-Chip (SOC) Design", Springer, 2005.
15.	Youn-Long Steve Lin, "Essential Issues in SOC Design Designing Complex Systems- on-Chip", Springer, 2006.
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МЕ	M19VDE302 - MEMS AND NEMS	т	Р	TU	С
₩.⊏.	(Common to VLSI & AE)	3	0	0	3

Course Objectives		
1.	To introduce the concepts of micro-electromechanical devices.	
2.	To know the fabrication process of Microsystems.	
3.	To know the design concepts of micro sensors.	
4.	To know the design concepts of micro actuators.	
5.	To familiarize concepts of quantum mechanics and nano systems.	

New trends in Engineering and Science: Micro and Nanoscale systems, Introduction to Design of MEMS and NEMS, MEMS and NEMS – Applications, Devices and structures. Materials for MEMS: Silicon, silicon compounds, polymers, metals.

**OVERVIEW** 

UNIT – II	MEMS FABRICATION TECHNOLOGIES	9
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Microsystem fabrication processes: Photolithography, Ion Implantation, Diffusion, Oxidation. Thin film depositions: LPCVD, Sputtering, Evaporation, Electroplating; Etching techniques: Dry and wet etching, electrochemical etching; Micromachining: Bulk Micromachining, Surface Micromachining, High Aspect-Ratio (LIGA and LIGA-like) Technology; Packaging: Microsystems packaging, Essential packaging technologies, Selection of packaging materials.

# UNIT – III

UNIT – I

# **MICRO SENSORS**

MEMS Sensors: Design of Acoustic wave sensors, resonant sensor, Vibratory gyroscope, Capacitive and Piezo Resistive Pressure sensors- engineering mechanics behind these Microsensors. Case study: Piezo-resistive pressure sensor.

# UNIT – IV

# MICRO ACTUATORS

Design of Actuators: Actuation using thermal forces, Actuation using shape memory Alloys, Actuation using piezoelectric crystals, Actuation using Electrostatic forces (Parallel plate, Torsion bar, Comb drive actuators), Micromechanical Motors and pumps. Case study: Comb drive actuators.

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UNIT – V

#### NANOSYSTEMS AND QUANTUM MECHANICS

Atomic Structures and Quantum Mechanics, Molecular and Nanostructure Dynamics: Schrodinger Equation and wave function theory, Density Functional Theory, Nanostructures and Molecular Dynamics, Electromagnetic Fields and their quantization, Molecular Wires and Molecular Circuits.

### **Total Instructional hours: 45**

	Course Outcomes : Students will be able to
CO1	Outline the concepts of micro-electromechanical devices.
CO2	Explain the fabrication process of Microsystems.
CO3	Design the concepts of micro sensors.
CO4	Design the concepts of micro actuators.
CO5	Explain concepts of quantum mechanics and nano systems.

	Reference Books
1.	Chang Liu, "Foundations of MEMS", Pearson education India limited, 2006.
2.	Marc Madou, "Fundamentals of Micro-fabrication", CRC press, 1997.
3.	Stephen D. Senturia, "Micro system Design", Kluwer Academic Publishers, 2001.
4.	Sergey Edward Lyshevski, "MEMS and NEMS: Systems, Devices, and Structures", CRC Press, 2002.
5.	Tai Ran Hsu, "MEMS and Microsystems Design and Manufacture", Tata McGraw Hill, 2002.

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# **Professional Elective - V**

	M19VDE304 - SOLID STATE DEVICE MODELLING	т	Р	ΤU	С
M.E.	AND SIMULATION				
	(Common to VLSI & AE)	3	0	0	3

	Course Objectives
1.	To understand the basic concept of device modelling.
2.	To learn concept of device modelling.
3.	To learn multistep method.
4.	To learn the mathematical techniques in device simulations.
5.	To study about the simulation of devices.

### MOSFET DEVICE PHYSICS MOSFET

capacitor, Basic operation, Basic modeling, Advanced MOSFET modeling, RF modeling of MOS transistors, Equivalent circuit representation of MOS transistor, High frequency behavior of MOS transistor and A.C small signal modeling, model parameter extraction, modeling parasitic BJT, Resistors, Capacitors, Inductors.

#### DEVICE MODELLING

Prime importance of circuit and device simulations in VLSI; Nodal, mesh, modified nodal and hybrid analysis equations. Solution of network equations: Sparse matrix techniques, solution of nonlinear networks through Newton-Raphson technique, convergence and stability.

UNIT – III

UNIT – II

UNIT – I

#### MULTISTEP METHODS

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Solution of stiff systems of equations, adaptation of multistep methods to the solution of electrical networks, general purpose circuit simulators.

#### UNIT – IV

#### MATHEMATICAL TECHNIQUES DEVICE SIMULATIONS

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Poisson equation, continuity equation, drift-diffusion equation, Schrodinger equation, hydrodynamic equations, trap rate, finite difference solutions to these equations in 1D and 2D space, grid generation.

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#### UNIT – V

#### SIMULATION OF DEVICES

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Computation of characteristics of simple devices like p-n junction, MOS capacitor and MOSFET; Small-signal analysis.

# Total Instructional hours: 45

	Course Outcomes : Students will be able to
CO1	Analyze the circuits using basic modelling, advanced modelling and parasitic BJT parameters.
CO2	Analyze the various device modelling techniques and newton Raphson method.
CO3	Apply and determine the Multistep methods and stiff system equation.
CO4	Analyse the mathematical equations involved in device simulation.
CO5	Explain the small signal analysis of MOS Capacitor.

	Reference Books
1.	Arora, N., "MOSFET Modelling for VLSI Simulation", Cadence Design Systems, 2007.
2.	Chua, L.O. and Lin, P.M., "Computer-Aided Analysis of Electronic Circuits: Algorithms and Computational Techniques", Prentice-Hall, 1975.
3.	Fjeldly, T., Yetterdal, T. and Shur, M., "Introduction to Device Modelling and Circuit Simulation", Wiley-Interscience., 1997.
4.	Grasser, T., "Advanced Device Modelling and Simulation", World Scientific Publishing Company, 2003.
5.	Selberherr, S., "Analysis and Simulation of Semiconductor Devices", Springer- Verlag., 1984.
6.	Trond Ytterdal, Yuhua Cheng and Tor A. Fjeldly Wayne Wolf, "Device Modelling for Analog and RF CMOS Circuit Design", John Wiley & Sons Ltd.

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мг	M19AEE303 - ADVANCED DIGITAL IMAGE PROCESSING	Т	Ρ	TU	С
	(Common to AE & VLSI)	3	0	0	3

Course Objectives		
1.	To understand the fundamentals of digital image processing.	
2.	To learn concept of color image processing technique.	
3.	To learn morphological image processing algorithms.	
4.	To learn segmentation algorithms and descriptors for image processing.	
5.	To study object recognition and image processing applications.	

### UNIT – I FUNDAMENTALS OF DIGITAL IMAGE PROCESSING

Elements of Visual Perception- Image acquisition, digitization- Histogram - Image enhancement – Spatial filters for smoothing and sharpening – Discrete 2D transforms - DFT, DCT, Walsh-Hadamard, Slant, KL, Wavelet Transform – Haar wavelet.

#### COLOR IMAGE PROCESSSING

Color Image Fundamentals-Color Models- RGB, CMY, CMYK and HSI Color Models- Pseudocolor Image Processing - Intensity Slicing- Intensity to Color transformations -Basics of Color Image Processing-Color Transformation - Color Image Smoothing and Sharpening- Color Segmentation - Noise in Color Images.

UNIT – III

# MORPHOLOGICAL IMAGE PROCESSING

Preliminaries- Basic Concepts from Set Theory-Logic Operations Involving Binary Images - Dilation and Erosion –Opening and Closing - Hit-or-Miss Transformation - Basic Morphological Algorithms -Boundary Extraction- Region Filling- Extraction of Connected Components- Convex Hull- Thinning-Thickening-Skeletons- Pruning- - Gray-Scale Morphology, Case Study.

UNIT – IV

#### SEGMENTATION, REPRESENTATION AND DESCRIPTION

Edge Detection - Edge Linking and Boundary Detection -Thresholding- Segmentation by Morphological Watershed Segmentation Algorithm - Use of Markers- Representation and Boundary Descriptors, Case Study.

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# UNIT – V OBJECT RECOGNITION AND IMAGE PROCESSING APPLICATIONS

Patterns and Pattern Classes -Recognition Based on Decision-Theoretic Methods – Matching Optimum Statistical Classifiers- Neural Networks, Fuzzy Systems - GA. Image compression- JPEG, JPEG2000 JBIG standards - Watermarking – Steganography.

### **Total Instructional hours: 45**

	Course Outcomes : Students will be able to
CO1	Explain about image acquisition, digitization and spatial filters for enhancement.
CO2	Outline color image processing techniques.
CO3	Apply morphological image processing algorithms.
CO4	Apply segmentation algorithms and descriptors for image processing.
CO5	Examine neural networks, fuzzy logic, genetic algorithms in object recognition, compression, watermarking and steganography algorithms to images

	Reference Books
1.	Rafael C. Gonzalez, "Digital Image Processing", Pearson Education Inc., 3 rd Edition, 2008.
2.	Milman Sonka, Vaclav Hlavac, Roger Boyle, "Image Processing, Analysis and Machine Vision", Brooks/Cloe, Vikas Publishing House, 2 nd Edition, 1999.
3.	Khalid Sayood, "Data Compression", Morgan Kaufmann Publishers (Elsevier)., 3 rd Edition, 2006.
4.	Rafael C. Gonzalez, Richards E.Woods, Steven Eddins, "Digital Image Processing using MATLAB", Pearson Education, Inc., 2004.
5.	Willam K.Pratt, "Digital Image Processing", John Wiley, New York, 2002.

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M.E.	M19AEE304 - PATTERN RECOGNITION	Т	Р	TU	С
	(Common to AE & VLSI)	3	0	0	3

	Course Objectives
1.	To learn about supervised pattern classifiers.
2.	To learn about unsupervised pattern classifiers.
3.	To familiarize about different feature extraction techniques.
4.	To explore the role of Hidden Marko model and SVM in pattern recognition.
5.	To study the application of Fuzzy logic and genetic algorithms for pattern classifier.

### UNIT – I PATTERN CLASSIFIER

Overview of Pattern recognition – Discriminant functions – Supervised learning –Parametric estimation – Maximum Likelihood Estimation – Bayesian parameter Estimation – Problems with Bayes approach– Pattern classification by distance functions – Minimum distance pattern classifier.

#### UNIT – II

Clustering for unsupervised learning and classification–Clustering concept – C Means algorithm – Hierarchical clustering – Graph theoretic approach to pattern Clustering – Validity of Clusters.

**CLUSTERING** 

# UNIT – III FEATURE EXTRACTION AND STRUCTURAL PATTERN RECOGNITION

Principle component analysis, Independent component analysis, Linear discriminant analysis, Feature selection through functional approximation – Elements of formal grammars, Syntactic description – Stochastic grammars – Structural Representation, Case Study.

#### UNIT – IV

HIDDEN MARKOV MODELS AND SUPPORT VECTOR MACHINE

State Machines – Hidden Markov Models – Training – Classification – Support vector Machine – Feature Selection, Case Study.

#### UNIT – V

# **RECENT ADVANCES**

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Fuzzy logic – Fuzzy Pattern Classifiers – Pattern Classification using Genetic Algorithms – Case Study Using Fuzzy Pattern Classifiers and Perception.

**Total Instructional hours: 45** 

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	Course Outcomes : Students will be able to	
CO1	Outline the concepts of supervised classifiers.	
CO2	Outline the concepts of Clustering.	
CO3	Classify the data and identify the patterns.	
CO4	Make use of feature set and select the features from given data set.	
CO5	Apply fuzzy logic and genetic algorithms for classification problems.	

	Reference Books
1.	Andrew Webb, "Stastical Pattern Recognition", Arnold publishers, London, 1999.
2.	C.M. Bishop, "Pattern Recognition and Machine Learning", Springer, 2006.
3.	M. Narasimha Murthy and V. Susheela Devi, "Pattern Recognition", Springer, 2011.
4.	Menahem Friedman and Abraham Kandel, "Introduction to Pattern Recognition Statistical, Structural, Neural and Fuzzy Logic Approaches", World Scientific publishing Co. Ltd, 2000.
5.	Robert J.Schalkoff, "Pattern Recognition Statistical, Structural and Neural Approaches", John Wiley & Sons Inc., New York, 1992.
6.	R.O. Duda, P.E.Hart and D.G.Stork, "Pattern Classification", John Wiley, 2001.
7.	S.Theodoridis and K.Koutroumbas, "Pattern Recognition", 4 th Ed., Academic Press, 2009.



ME		Т	Р	TU	С
IVI.C.	WIJAEE305 - SECURE COMPUTING STSTEMS	3	0	0	3

Course Objectives	
1.	To learn about computer security and management.
2.	To learn the hardware security.
3.	To study about the security in OS and its assembly.
4.	To study advanced computer architecture.
5.	To learn security issues in various types of computing networks.

# UNIT – I COMPUTER SECURITY AND MANAGEMENT

Overview of Computer Security, Threats, Malware, Vulnerabilities, Authentication, Access Control, Security Management Models, Security Management Practices, Protection Mechanisms, Legal aspects of security, Ethical Hacking.

Need for Hardware Security, Computer Memory and storage, Bus and Interconnection, I/O and Network Interface, CPU; Side channel Analysis: Power Analysis Attack, Timing Attack, Fault attack. Countermeasures of Side Channel Attack, Secure Hardware Intellectual Properties, Physically Unclonable Functions(PUFs), Secure PUF.

UNIT – III

# ASSEMBLY AND OPERATING SYSTEMS SECURITY

Opcode, Operands, Addressing Modes, Stack and Buffer Overflow, FIFO and M/M/1 Problem, Kernel, Drivers and OS Security; Secure Design Principles, Trusted Operating Systems, Trusted System Functions.

# UNIT – IV

# ADVANCED COMPUTER ARCHITECTURE

Security aspects: Multiprocessors, parallel processing, Ubiquitous computing, Grid, Distributed and cloud computing, Internet computing, Virtualization.

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#### UNIT – V

### NETWORK AND WEBSECURITY

TCP/IP Protocol, Network switches, Routers, Gateways, Wireless Networks and Network Address Translation (NAT); Network Security Issues in TCP/IP, Threat Models, Denial of Service Attacks, Firewalls, Intrusion Detection, Browser Attacks, Web Attacks Targeting Users, Email Attacks, Secure Shell (SSH), HTTPS.

# **Total Instructional hours: 45**

	Course Outcomes : Students will be able to
CO1	Outline the concepts of security management.
CO2	Explain about the hardware security.
CO3	Outline the operating system functions.
CO4	Explain the various processing and computing methods.
CO5	Classify the various security issues.

	Reference Books
1.	Charles B. Pfleeger, Shari Lawrence Pfleeger, "Security in Computing", Fourth Edition, Pearson Education, 2007.
2.	Debdeep Mukhopadhyay, Rajat Subhra Chakraborty, "Hardware Security - Design Threats and Safeguards", CRC Press, 2015.
3.	Michael Whitman, Herbert J. Mattord, "Management of Information Security", Third Edition, Course Technology, 2010.
4.	Shuangbao Wang, Robert S.Ledley, "Computer Architecture and Security", Wiley, 2013.
5.	William Stallings, "Network Security Essentials, Applications and Standards", Dorling Kindersley I P Ltd, Delhi, 2008.

Lane **BoS Chairman** 

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ME		Т	Р	TU	
IVI.C.	WIJAEF301 - PROJECT WORK (PHASE - I)	0	12	0	

	Course Objectives
1.	To enable a student to do an individual project work this may involve design, modelling, simulation and/or fabrication.
2.	To analyse a problem both theoretically and practically.
3.	To motivate the students to involve in research activities leading to innovative solutions for industrial and societal problems.

# **COURSE DESCRIPTION**

Project work shall be carried out by each and every individual student under the supervision of a faculty of this department. A student may however, in certain cases, be permitted to work for the project in association with other departments or in an Industrial/Research Organization, on the recommendation of the Head of the Department. In such cases, the project work shall be jointly supervised by a faculty of the Department and an Engineer / Scientist from the organization. The student shall meet the supervisor periodically and attend the periodic reviews for evaluating the progress.

Project work will be carried out in two phases, Phase-I during the third semester and Phase-II during the final semester. Phase-I shall be pursued for a minimum of 12 periods per week and Phase – II in 24 periods per week. In each phase, there will be three reviews for continuous internal assessment and one final review and viva voce at the end of the semesters. The Project Report prepared according to approved guidelines and duly signed by the supervisor(s) and the Head of the Department shall be submitted to the concerned department.

	Course Outcomes : Students will be able to		
CO1	Identify the area, narrow dine the problem and understand the problem thoroughly and provide an appropriate solution.		
CO2	Show the systematic literature survey which helps to build the knowledge in the chosen field by using the existing journal references		
CO3	Construct a mathematical model for the system under study.		
CO4	Choose and get proficiency over the software for simulation and analysis.		
CO5	Utilize the findings of the phase I work in conferences / journals.		

**BoS Chairman** 

# Semester - IV

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WI.C.	WIJAEF401 - PROJECT WORK (PHASE - II)	0	24	0	12

Course Objectives			
1.	To enable a student to do an individual project work this may involve design, modelling, simulation and/or fabrication.		
2.	To analyse a problem both theoretically and practically.		
3.	To motivate the students to involve in research activities leading to innovative solutions for industrial and societal problems		

# **COURSE DESCRIPTION**

Project work shall be carried out by each and every individual student under the supervision of a faculty of this department. A student may however, in certain cases, be permitted to work for the project in association with other departments or in an Industrial/Research Organization, on the recommendation of the Head of the Department. In such cases, the project work shall be jointly supervised by a faculty of the Department and an Engineer / Scientist from the organization. The student shall meet the supervisor periodically and attend the periodic reviews for evaluating the progress.

Project work will be carried out in two phases, Phase-I during the third semester and Phase-II during the final semester. Phase-II shall be pursued for 24 periods per week. In phase II also, there will be three reviews for continuous internal assessment and one final review and viva voce at the end of the semesters. The Project Report prepared according to approved guidelines and duly signed by the supervisor(s) and the Head of the Department shall be submitted to the concerned department.

Course Outcomes : Students will be able to			
CO1	Develop the project model for Phase - II.		
CO2	Apply modern engineering tools for simulation, analysis and Solution.		
CO3	Evaluate the findings of the project by attending conference and communicate to journals for publication.		
CO4	Take part in Presentation/ Technical Discussion.		
CO5	Improve the continuous learning in new practices, principles and techniques in Electronics area.		

**BoS Chairman**